

8-bit Proprietary Microcontroller CMOS

F²MC-8L MB89160L Series

MB89163L/165L/P165/W165/PV160

■ DESCRIPTION

The MB89160L series is a line of the general-purpose, single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers contain a variety of peripheral functions such as an LCD controller/driver, an A/D converter, timers, a serial interface, PWM timers, and external interrupts.

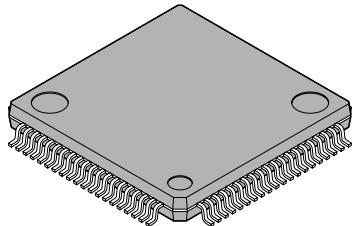
■ FEATURES

- F²MC-8L family CPU core
- Dual-clock control system
- Maximum memory size: 16-Kbyte ROM, 512-byte RAM (Max)
- Minimum execution time: 0.95 μ s/4.2 MHz
- I/O ports: Max 54 channels
- 21-bit time-base timer
- 8/16-bit timer/counter: 2 or 1 channels
- 8-bit serial I/O: 1 channel
- External interrupts (wake-up function): Four channels with edge detection plus eight level-interrupt channels
- 8-bit A/D converter: 8 channels
- 8-bit PWM timers: 2 channels
- Watch prescaler (15 bits)
- LCD controller/driver: 24 segments \times 4 commons (Max 96 pixels)
- Remote control transmission output
- Buzzer output
- Power-on reset function (option)
- Low-power consumption modes (stop, sleep, and watch mode)
- CMOS technology

MB89160L Series

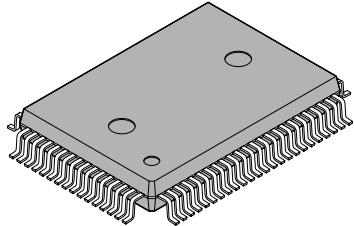
■ PACKAGES

80-pin Plastic LQFP



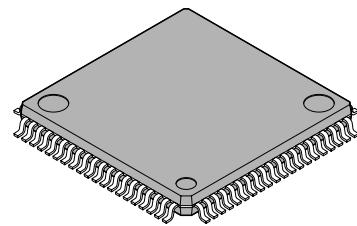
(FPT-80P-M05)

80-pin Plastic QFP



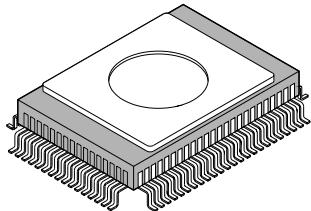
(FPT-80P-M06)

80-pin Plastic LQFP



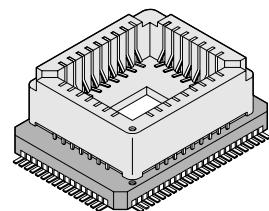
(FPT-80P-M11)

80-pin Ceramic QFP



(FPT-80C-A02)

80-pin Ceramic MQFP



(MQP-80C-P01)

MB89160L Series

■ PRODUCT LINEUP

Parameter \ Part number	MB89163L	MB89165L	MB89P165	MB89W165	MB89PV160
Classification	Mass production products (mask ROM products)		One-time PROM product	EPROM product	Piggyback/ evaluation product (for development)
ROM size	8 K × 8 bits (internal mask ROM)	16 K × 8 bits (internal mask ROM)	16 K × 8 bits (internal PROM, programming with general-purpose EPROM programmer)		32 K × 8 bits (external ROM)
RAM size	256 × 8 bits		512 × 8 bits		
CPU functions		Number of instructions : 136 Instruction bit length : 8 bits Instruction length : 1 to 3 bytes Data bit length : 1, 8, 16 bits Minimum execution time : 0.95 µs/4.2 MHz Interrupt processing time : 8.6 µs to 137.1 µs/4.2 MHz			
Ports		I/O port (N-ch open-drain) : 8 (6 ports also serve as peripherals, 3 ports are a heavy-current drive type.) Output ports (N-ch open-drain) : 28 (16 ports also serve as segment pins, 2 ports serve as common pins, 2 ports serve as common pins.) *2 I/O ports (CMOS) : 16 (12 ports also serve as an external interrupt) Output ports (CMOS) : 2 (Also serve as peripherals) Total : 54 (Max)			
Timer/counter	8-bit timer operation (toggled output capable, operating clock cycle 1.9 µs to 487.6 µs) 16-bit timer operation (toggled output capable, operating clock cycle 1.9 µs to 487.6 µs)				
Serial I/O		8 bits LSB first/MSB first selectability One clock selectable from four operation clocks (one external shift clock, three internal shift clocks: 1.9 µs, 7.6 µs, 30.5 µs)			
LCD controller/ driver	Common output : 4 (Max)*2 Segment output : 24 (Max) *2 Bias power supply pins : 4 LCD display RAM size : 24 × 4 bits Dividing resistor for LCD driving : Built-in (an external resistor selectability)				
A/D converter		8-bit resolution × 8 channels Sense mode (conversion time 11.9 µs/4.2 MHz) Continuous activation by an internal timer capable Reference voltage input			
	A/D conversion mode (conversion time 49.5 µs/4.2 MHz (52 instruction cycles))		A/D conversion mode (conversion time 43 µs/4.2 MHz (44 instruction cycles))		

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MB89160L Series

(Continued)

Part number Parameter	MB89163L	MB89165L	MB89P165	MB89W165	MB89PV160
PWM timer 1, PWM timer 2	8 bits × 2 channels 8-bit reload timer operation (toggled output capable, operating clock cycle: 0.95 µs to 124 ms) 8-bit resolution PWM operation (conversion cycle: 243.8 µs to 63.9 s)				
External interrupt 1 (wake-up function)	4 independent channels (edge selectability) Rising edge/falling edge selectability Used also for wake-up from stop/sleep mode. (Edge detection is also permitted in stop mode.)				
External interrupt 2 (wake-up function)	“L” level interrupts × 8 channels				
Buzzer output	1 (7 frequencies are selectable by the software.)				
Remote control transmission output	1 (Pulse width and cycle are software selectable.)				
Standby modes	Subclock mode, sleep mode, stop mode, and watch mode				
Process	CMOS				
Operating voltage	2.2 V to 3.6 V *1		2.7 V to 6.0 V		
EPROM for use					MBM27C256A-20TV

*1 : Varies with conditions such as the operating frequency. (The operating voltage of the A/D converter is assured separately. See ■ ELECTRICAL CHARACTERISTICS.)

*2 : See ■ MASK OPTIONS.

■ PACKAGE AND CORRESPONDING PRODUCTS

Package	MB89163L	MB89165L	MB89P165	MB89W165	MB89PV160
FPT-80P-M05	○	○	○	×	×
FPT-80P-M06	○	○	○	×	×
FPT-80P-M11	○	○	○	×	×
FPT-80C-A02	×	×	×	○	×
MQP-80C-P01	×	×	×	×	○

○ : Available × : Not available

Note : For more information about each package, see ■ PACKAGE DIMENSIONS.

MB89160L Series

■ DIFFERENCES AMONG PRODUCTS

1. Memory Size

Before evaluating using the piggyback product, verify its differences from the product that will actually be used. Take particular care on the following points:

- On the MB89163L, addresses 0180_H and later of the register bank cannot be used.
- The stack area, etc., is set at the upper limit of the RAM.

2. Current Consumption

- In the case of the MB89PV160, add the current consumed by the EPROM which is connected to the top socket.
- When operated at low speed, the product with an OTPROM (one-time PROM) or an EPROM will consume more current than the product with a mask ROM.

However, the current consumption in the sleep/stop modes is the same. (For more information, see ■ ELECTRICAL CHARACTERISTICS.)

3. Mask Options

Functions that can be selected as options and how to designate these options vary by the product.

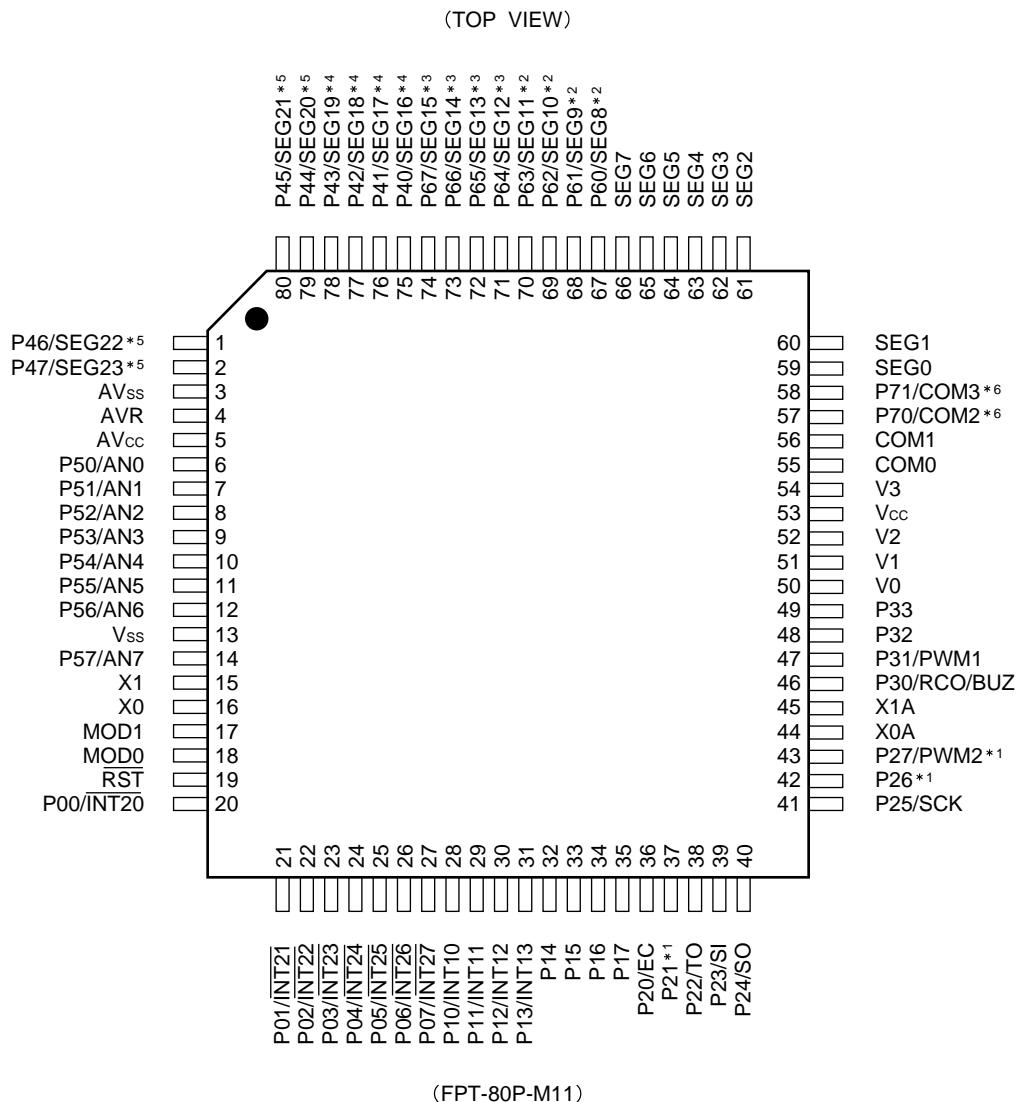
Before using options check ■ MASK OPTIONS.

Take particular care on the following points:

- A pull-up resistor cannot be set for P20 to P27, P40 to P47 and P60 to P67 on the MB89P165/W165.
- A pull-up resistor is not selectable for P40 to P47 and P60 to P67 if they are used as LCD pins.
- Options are fixed on the MB89PV160.

MB89160L Series

■ PIN ASSIGNMENTS



*1 : N-ch open-drain heavy-current drive type

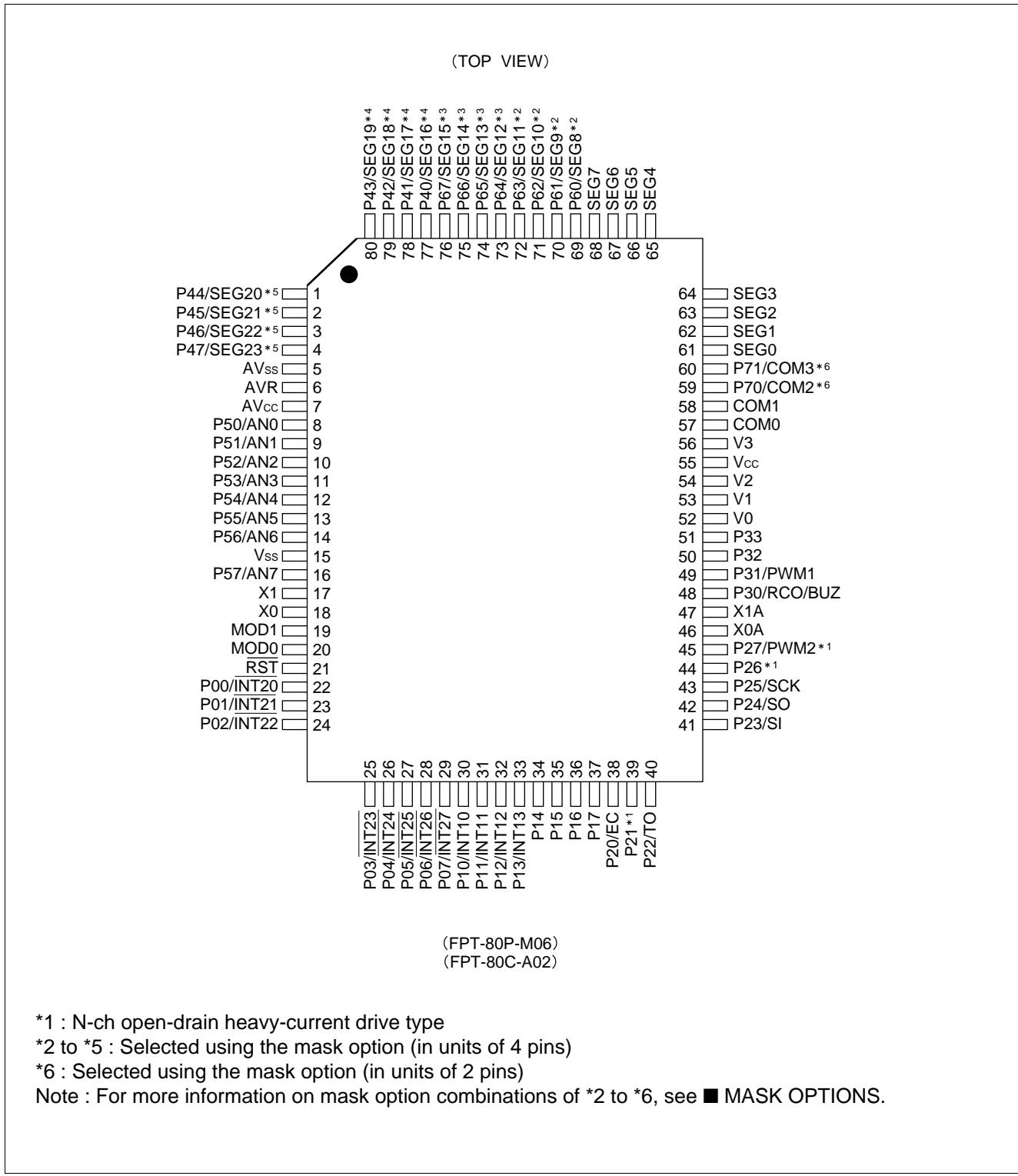
*2 to *5 : Output selected using the mask option (in units of 4 pins)

*6 : Output selected using the mask option (in units of 2 pins)

Note : For more information on output selected combinations of *2 to *6, see ■ MASK OPTIONS.

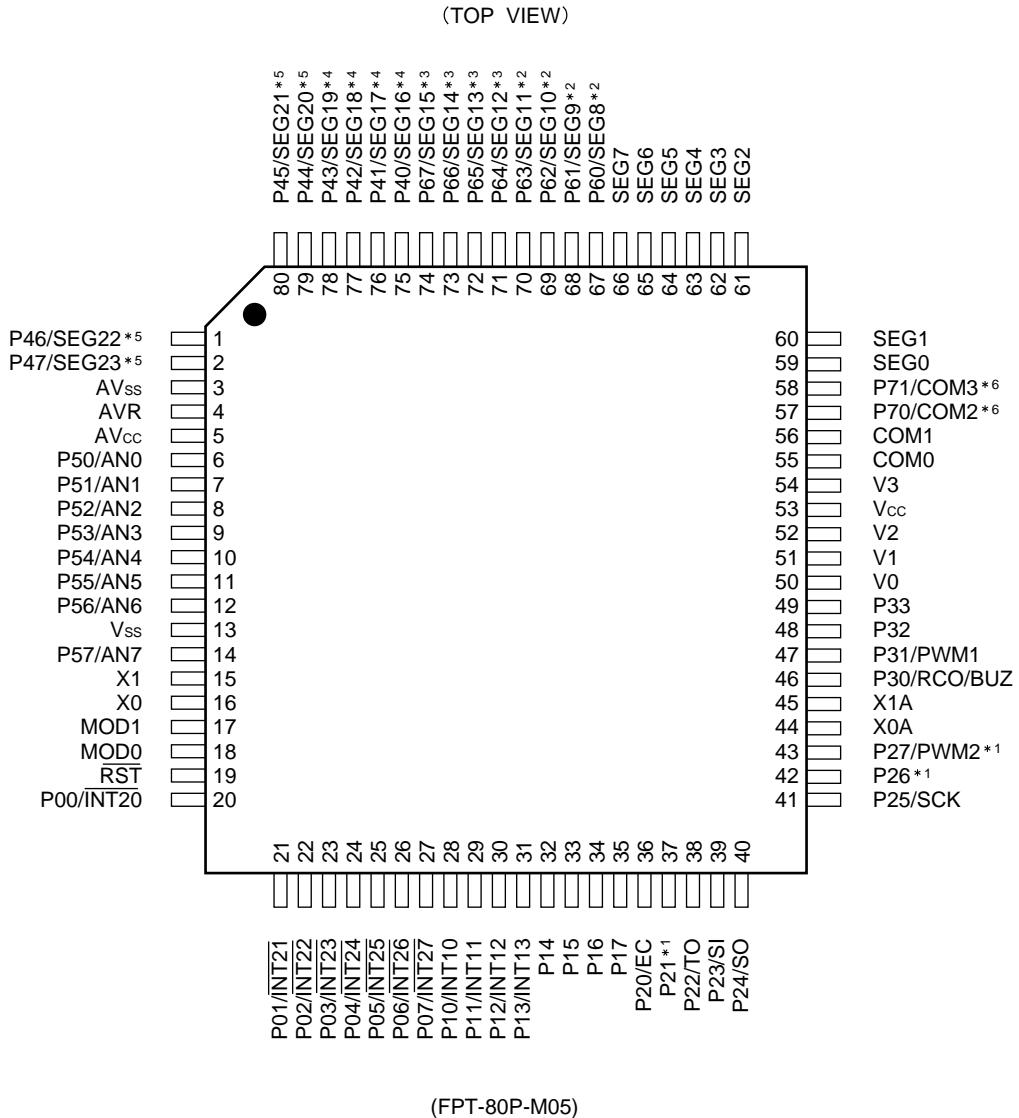
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MB89160L Series



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MB89160L Series



*1 : N-ch open-drain heavy-current drive type

*2 to *5 : Selected using the mask option (in units of 4 pins)

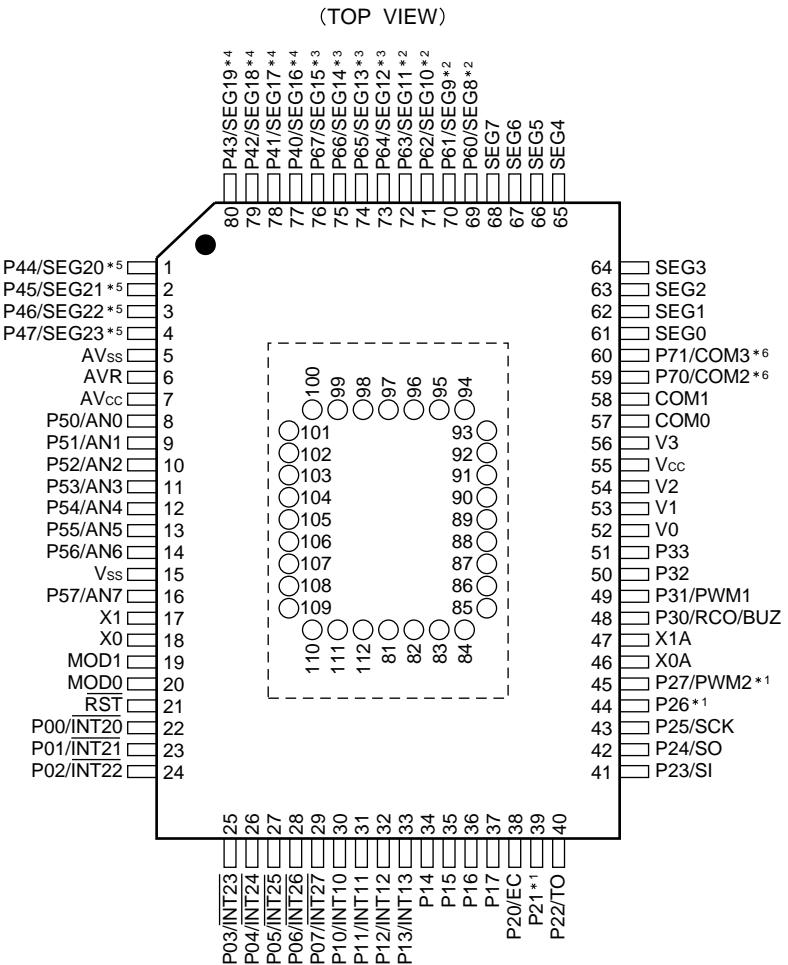
*6 : Selected using the mask option (in units of 2 pins)

Note : For more information on mask option combinations of *2 to *6, see ■ MASK OPTIONS.

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MB89160L Series

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*1 : N-ch open-drain heavy-current drive type

*2 to *5 : Selected using the mask option (in units of 4 pins)

*6 : Selected using the mask option (in units of 2 pins)

Note : For more information on mask option combinations of *2 to *6, see ■ MASK OPTIONS.

- Pin assignment on package top (MB89PV160 only)

Pin no.	Pin name	Pin no.	Pin name	Pin no.	Pin name	Pin no.	Pin name
81	N.C.	89	A2	97	N.C.	105	OE
82	V _{PP}	90	A1	98	O4	106	N.C.
83	A12	91	A0	99	O5	107	A11
84	A7	92	N.C.	100	O6	108	A9
85	A6	93	O1	101	O7	109	A8
86	A5	94	O2	102	O8	110	A13
87	A4	95	O3	103	CE	111	A14
88	A3	96	V _{ss}	104	A10	112	V _{cc}

N.C.: Internally connected. Do not use.

MB89160L Series

■ PIN DESCRIPTION

Pin no.		Pin name	Circuit type	Function
SQFP ^{*1} QFP ^{*2}	MQFP ^{*3} QFP ^{*4}			
16	18	X0	A	Main clock crystal oscillator pins
15	17	X1		
18	20	MOD0	C	Operating mode selection pins
17	19	MOD1		Connect directly to V _{SS} .
19	21	$\overline{\text{RST}}$	D	Reset I/O pin This pin is an N-ch open-drain output type with a pull-up resistor, and a hysteresis input type. "L" is output from this pin by an internal reset source. The internal circuit is initialized by the input of "L".
20 to 27	22 to 29	P00/ $\overline{\text{INT20}}$ to P07/ $\overline{\text{INT27}}$	E	General-purpose I/O ports Also serve as an external interrupt 2 input (wake-up function). External interrupt 2 input is hysteresis input.
28 to 31	30 to 33	P10/INT10 to P13/INT13	E	General-purpose I/O ports Also serve as an external interrupt 1 input. External interrupt 1 input is hysteresis input.
32 to 35	34 to 37	P14 to P17	F	General-purpose I/O ports
36	38	P20/EC	H	N-ch open-drain general-purpose I/O port Also serves as the external clock input for the timer. The peripheral is a hysteresis input type.
37	39	P21	I	N-ch open-drain general-purpose I/O port
38	40	P22/TO	I	N-ch open-drain general-purpose I/O port Also serves as a timer output.
39	41	P23/SI	H	N-ch open-drain general-purpose I/O port Also serves as the data input for the serial I/O. The peripheral is a hysteresis input type.
40	42	P24/SO	I	N-ch open-drain general-purpose I/O port Also serves as the data output for the serial I/O.
41	43	P25/SCK	H	N-ch open-drain general-purpose I/O port Also serves as the clock I/O for the serial I/O. The peripheral is a hysteresis input type.
42	44	P26	I	N-ch open-drain general-purpose I/O port
43	45	P27/PWM2	I	N-ch open-drain general-purpose I/O port Also serves as the square wave or PWM wave output for the 8-bit PWM timer 2.
49	51	P33	J	Functions as an N-ch open-drain general-purpose output port only.

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MB89160L Series

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Pin no.		Pin name	Circuit type	Function
SQFP ^{*1} QFP ^{*2}	MQFP ^{*3} QFP ^{*4}			
48	50	P32	J	Functions as an N-ch open-drain general-purpose output port only.
47	49	P31/PWM1	G	General-purpose output-only port Also serves as the square wave or PWM wave output for the 8-bit PWM timer 1.
46	48	P30/RCO/BUZ	G	General-purpose output-only port Also serves as a buzzer output and a remote control transmission frequency output.
14, 12 to 6	16, 14 to 8	P57/AN7 to P50/AN0	L	N-ch open-drain general-purpose output ports Also serve as an analog input.
2, 1, 80 to 75	4 to 1 80 to 77	P47/SEG23 to P40/SEG16	J/K	N-ch open-drain general-purpose output ports Also serve as an LCD controller/driver segment output. Switching between port and segment output is done by the mask option.
74 to 67	76 to 69	P67/SEG15 to P60/SEG8	J/K	
66 to 59	68 to 61	SEG7 to SEG0	K	LCD controller/driver segment output pins
58, 57	60, 59	P71/COM3, P70/COM2	J/K	N-ch open-drain general-purpose output ports Also serve as an LCD controller/driver common output. Switching between port and common output is done by the mask option.
56, 55	58, 57	COM1, COM0	K	LCD controller/driver common output-only pins
54, 52 to 50	56, 54 to 52	V3, V2 to V0	—	LCD driving power supply pins
44	46	X0A	B	Subclock crystal oscillator pins (32.768 KHz)
45	47	X1A		
53	55	V _{cc}	—	Power supply pin
13	15	V _{ss}	—	Power supply (GND) pin
5	7	A _V _{cc}	—	A/D converter power supply pin Use this pin at the same voltage as V _{cc} .
4	6	A _V _R	—	A/D converter reference voltage input pin
3	5	A _V _{ss}	—	A/D converter power supply pin Use this pin at the same voltage as V _{ss} .

*1 : FPT-80P-M05

*2 : FPT-80P-M11

*3 : MQP-80C-P01

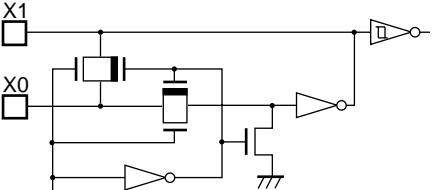
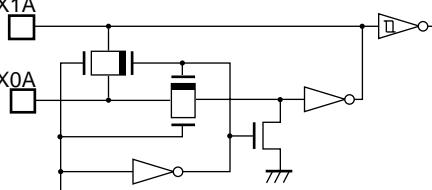
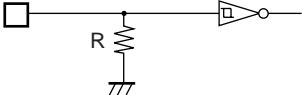
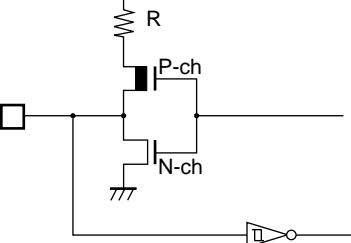
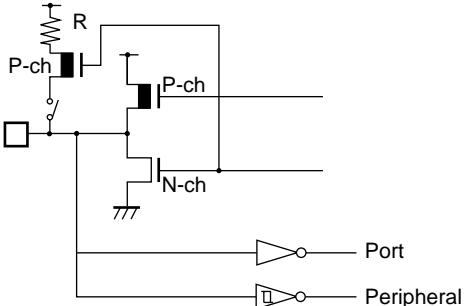
*4 : FPT-80P-M06, FPT-80C-A02

MB89160L Series

- External EPROM pins (MB89PV160 only)

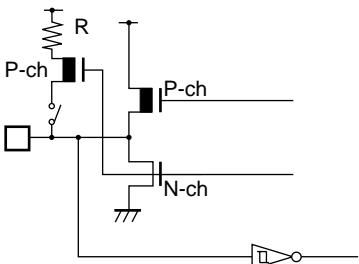
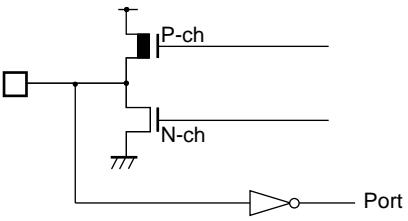
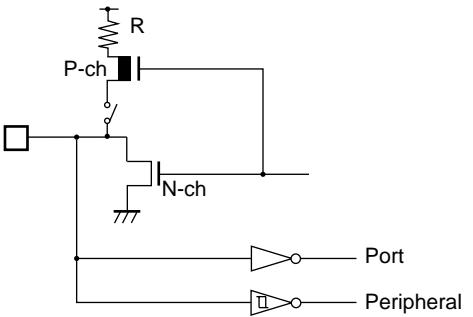
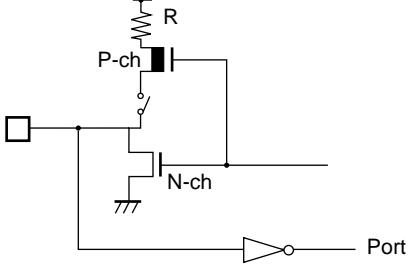
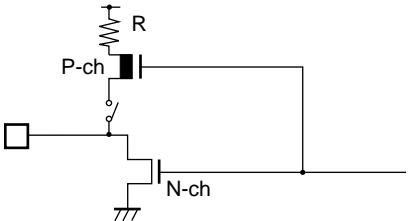
Pin no.	Pin name	I/O	Function
82	V _{PP}	O	"H" level output pin
83	A12		
84	A7		
85	A6		
86	A5		
87	A4	O	Address output pins
88	A3		
89	A2		
90	A1		
91	A0		
93	O1		
94	O2	I	Data input pins
95	O3		
96	V _{ss}	O	Power supply (GND) pin
98	O4		
99	O5		
100	O6	I	Data input pins
101	O7		
102	O8		
103	\overline{CE}	O	ROM chip enable pin Outputs "H" during standby.
104	A10	O	Address output pin
105	\overline{OE}	O	ROM output enable pin Outputs "L" at all times.
107	A11		
108	A9		
109	A8		
110	A13	O	Address output pins
111	A14		
112	V _{cc}	O	EPROM power supply pin
81	N.C.	—	Internally connected pins Be sure to leave them open.
92			
97			
106			

■ I/O CIRCUIT TYPE

Type	Circuit	Remarks
A	 <p>Standby control signal</p>	<p>Main clock</p> <ul style="list-style-type: none"> At an oscillation feedback resistor of approximately 1 MΩ
B	 <p>Standby control signal</p>	<p>Subclock</p> <ul style="list-style-type: none"> At an oscillation feedback resistor of approximately 4.5 MΩ
C		<ul style="list-style-type: none"> Hysteresis input The pull-down resistor (R) is approximately 50 kΩ for MB89163L/165L only.
D		<ul style="list-style-type: none"> At an output pull-up resistor of approximately 50 kΩ Hysteresis input
E	 <p>Port</p> <p>Peripheral</p>	<ul style="list-style-type: none"> CMOS I/O The peripheral is a hysteresis input type. Pull-up resistor optional (Not available on the MB89PV160.)

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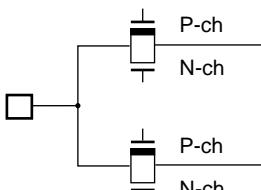
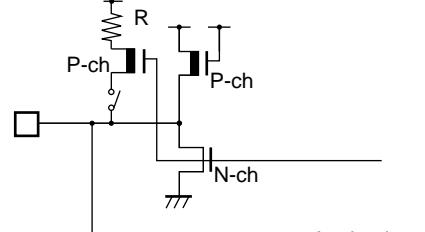
MB89160L Series

Type	Circuit	Remarks
F		<ul style="list-style-type: none"> CMOS I/O Pull-up resistor optional (Not available on the MB89PV160)
G		<ul style="list-style-type: none"> CMOS output P-ch output is a heavy-current drive type.
H		<ul style="list-style-type: none"> N-ch open-drain I/O CMOS input The peripheral is a hysteresis input type. P21, P26 and P27 are a heavy-current drive type. Pull-up resistor optional (Not available on the MB89P165, MB89W165 and MB89PV160)
I		<ul style="list-style-type: none"> N-ch open-drain output CMOS input Pull-up resistor optional (Not available on the MB89P165, MB89W165 and MB89PV160)
J		<ul style="list-style-type: none"> N-ch open-drain output Pull-up resistor optional (Not available on the MB89P165, MB89W165 and MB89PV160) P32 and P33 are not provided with a pull-up resistor.

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MB89160L Series

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Type	Circuit	Remarks
K		<ul style="list-style-type: none"> • LCD controller/driver segment output
L	 <p>Analog input</p>	<ul style="list-style-type: none"> • N-ch open-drain output • Analog input • Pull-up resistor optional (Not available on the MB89PV160)

MB89160L Series

■ HANDLING DEVICES

1. Preventing Latchup

Latchup may occur on CMOS ICs if voltage higher than V_{CC} or lower than V_{SS} is applied to input and output pins other than medium- to high-voltage pins or if higher than the voltage which shows on "1. Absolute Maximum Ratings" in ■ ELECTRICAL CHARACTERISTICS is applied between V_{CC} and V_{SS} .

When latchup occurs, power supply current increases rapidly and might thermally damage elements. When using, take great care not to exceed the absolute maximum ratings.

Also, take care to prevent the analog power supply (AV_{CC} and AV_{SS}) and analog input from exceeding the digital power supply (V_{CC}) when the analog system power supply is turned on and off.

2. Treatment of Unused Input Pins

Leaving unused input pins open could cause malfunctions. They should be connected to a pull-up or pull-down resistor.

3. Treatment of Power Supply Pins on Microcontrollers with A/D and D/A Converters

Connect to be $AV_{CC} = DAV_{CC} = V_{CC}$ and $AV_{SS} = AVR = V_{SS}$ even if the A/D and D/A converters are not in use.

4. Treatment of N.C. Pin

Be sure to leave (internally connected) N.C. pins open.

5. Power Supply Voltage Fluctuations

Although V_{CC} power supply voltage is assured to operate within the rated range, a rapid fluctuation of the voltage could cause malfunctions, even if it occurs within the rated range. Stabilizing voltage supplied to the IC is therefore important. As stabilization guidelines, it is recommended to control power so that V_{CC} ripple fluctuations (P-P value) will be less than 10% of the standard V_{CC} value at the commercial frequency (50 Hz to 60 Hz) and the transient fluctuation rate will be less than 0.1 V/ms at the time of a momentary fluctuation such as when power is switched.

6. Precautions when Using an External Clock

Even when an external clock is used, oscillation stabilization time is required for power-on reset (optional) and wake-up from stop mode.

7. Note on Noise in the External Reset Pin (\overline{RST})

If the reset pulse applied to the external reset pin (\overline{RST}) does not meet the specifications, it may cause malfunctions. Use caution so that the reset pulse less than the specifications will not be fed to the external reset pin (\overline{RST}).

■ PROGRAMMING TO THE EPROM ON THE MB89P165

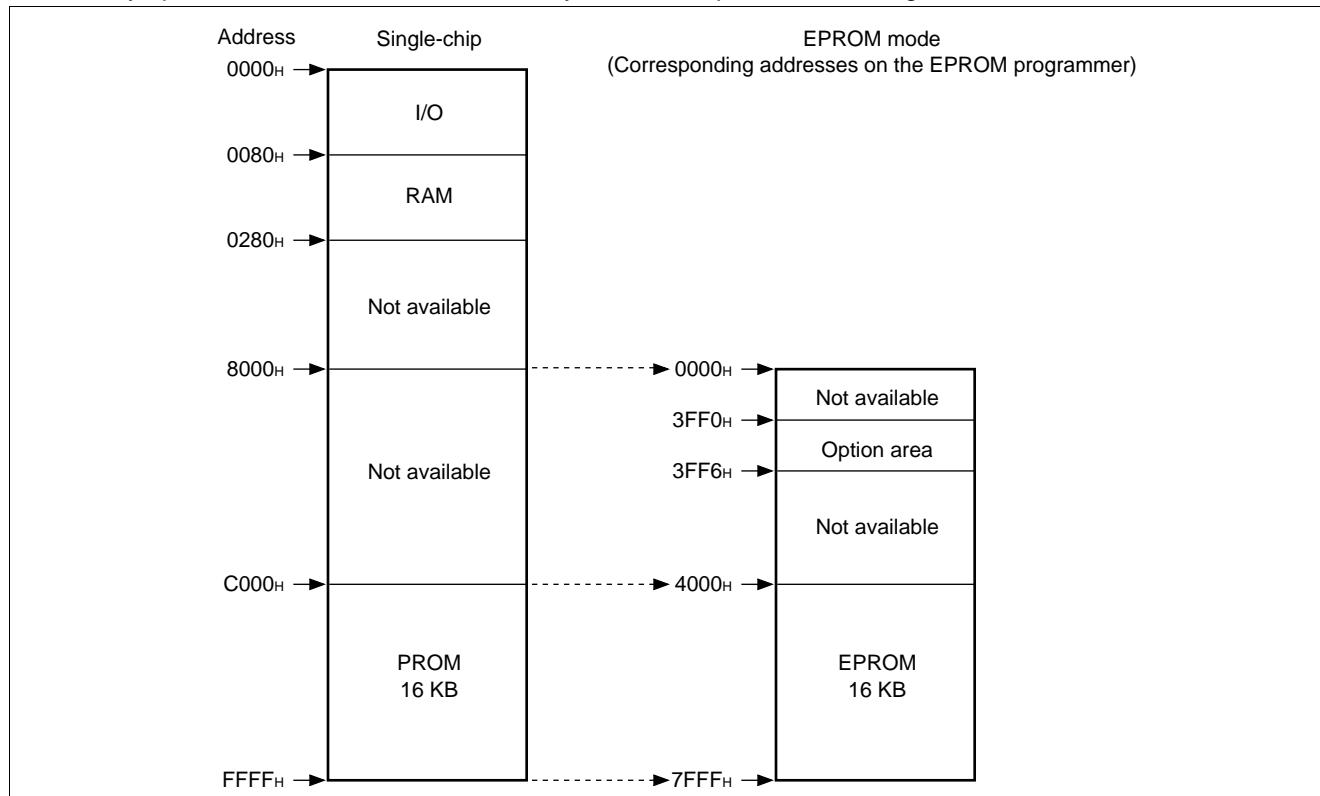
The MB89P165 is an OTPROM version of the MB89160 series.

1. Features

- 32-Kbyte PROM on chip
- Options can be set using the EPROM programmer.
- Equivalency to the MBM27C256A in EPROM mode (when programmed with the EPROM programmer)

2. Memory Space

Memory space in each mode such as 32-Kbyte PROM, option area is diagrammed below.



3. Programming to the EPROM

In EPROM mode, the MB89P165 functions equivalent to the MBM27C256A. This allows the PROM to be programmed with a general-purpose EPROM programmer (the electronic signature mode cannot be used) by using the dedicated socket adapter.

When the operating area for a single chip is 16 Kbyte (C000H to FFFFH) the PROM can be programmed as follows:

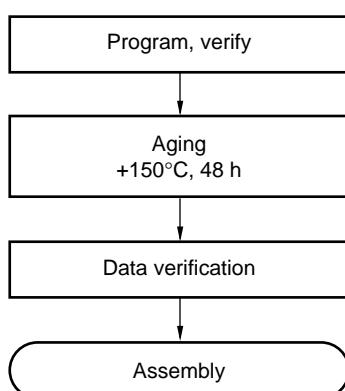
• Programming procedure

- (1) Set the EPROM programmer to the MBM27C256A.
- (2) Load program into the EPROM programmer at 4000H to 7FFFH.
(Note that addresses C000H to FFFFH while operating as a single chip assign to 4000H to 7FFFH in EPROM mode.)
Load option data into address 3FF0H to 3FF5H of the EPROM programmer.
(For information about each corresponding option, see "8. Setting OTPROM Options.")
- (3) Program with the EPROM programmer.

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4. Recommended Screening Conditions

High-temperature aging is recommended as the pre-assembly screening procedure for a product with a blanked OTPROM microcomputer program.



5. Programming Yield

All bits cannot be programmed at Fujitsu shipping test to a blanked OTPROM microcomputer, due to its nature. For this reason, a programming yield of 100% cannot be assured at all times.

6. EPROM Programmer Adapter Socket

Package	Compatible adapter socket
FPT-80P-M05	ROM-80SQF-28DP-8L
FPT-80P-M06	ROM-80QF-28DP-8L3
FPT-80P-M11	ROM-80QF2-28DP-8L2

7. Erasure

In order to clear all locations of their programmed contents, it is necessary to expose the internal EPROM to an ultraviolet light source. A dosage of 10 W-seconds/cm² is required to completely erase an internal EPROM. This dosage can be obtained by exposure to an ultraviolet lamp (wavelength of 2537 Angstroms (Å)) with intensity of 12000 µW/cm² for 15 to 21 minutes. The internal EPROM should be about one inch from the source and all filters should be removed from the UV light source prior to erasure.

It is important to note that the internal EPROM and similar devices, will erase with light sources having wavelengths shorter than 4000Å. Although erasure time will be much longer than with UV source at 2537Å, nevertheless the exposure to fluorescent light and sunlight will eventually erase the internal EPROM, and exposure to them should be prevented to realize maximum system reliability. If used in such an environment, the package windows should be covered by an opaque label or substance.

MB89160L Series

8. Setting OTPROM Options

- OTPROM option bit map

	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
3FF0 _H	Vacancy Readable	Vacancy Readable	Oscillation stabilization time WTM1 WTM0 See ■ MASK OPTIONS.		Vacancy Readable	Reset pin output 1: Yes 0: No	Clock mode selection 1: Dual clock 0: Single clock	Power-on reset 1: Yes 0: No
	P07 Pull-up 1: No 0: Yes	P06 Pull-up 1: No 0: Yes	P05 Pull-up 1: No 0: Yes	P04 Pull-up 1: No 0: Yes		P03 Pull-up 1: No 0: Yes	P02 Pull-up 1: No 0: Yes	P01 Pull-up 1: No 0: Yes
3FF1 _H	P17 Pull-up 1: No 0: Yes	P16 Pull-up 1: No 0: Yes	P15 Pull-up 1: No 0: Yes	P14 Pull-up 1: No 0: Yes	P13 Pull-up 1: No 0: Yes	P12 Pull-up 1: No 0: Yes	P11 Pull-up 1: No 0: Yes	P10 Pull-up 1: No 0: Yes
3FF2 _H	P57 Pull-up 1: No 0: Yes	P56 Pull-up 1: No 0: Yes	P55 Pull-up 1: No 0: Yes	P54 Pull-up 1: No 0: Yes	P53 Pull-up 1: No 0: Yes	P52 Pull-up 1: No 0: Yes	P51 Pull-up 1: No 0: Yes	P50 Pull-up 1: No 0: Yes
3FF4 _H	Vacancy Readable	Vacancy Readable	Vacancy Readable	Vacancy Readable	Vacancy Readable	Vacancy Readable	Vacancy Readable	Vacancy Readable
3FF5 _H	Vacancy Readable	Vacancy Readable	Vacancy Readable	Vacancy Readable	Vacancy Readable	Vacancy Readable	Vacancy Readable	Vacancy Readable

Notes : • Set each bit to 1 to erase.

- Do not write 0 to the vacant bit.

The read value of the vacant bit is 1, unless 0 is written to it.

MB89160L Series

■ PROGRAMMING TO THE EPROM WITH PIGGYBACK/EVALUATION DEVICE

1. EPROM for Use

MBM27C256A-20TV

2. Programming Socket Adapter

To program to the PROM using an EPROM programmer, use the socket adapter (manufacturer: Sun Hayato Co., Ltd.) listed below.

Package	Adapter socket part number
LCC-32 (Rectangle)	ROM-32LC-28DP-YG

Inquiry: Sunhayato Corp.

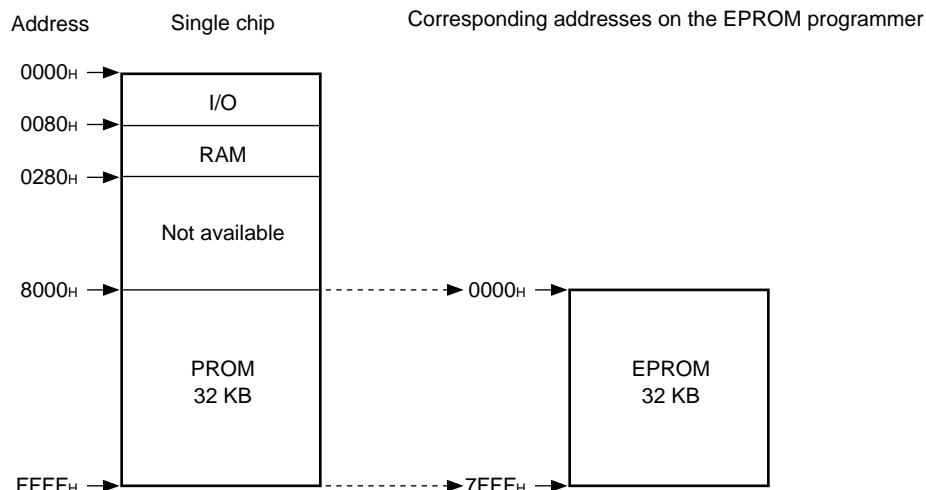
TEL : 81-3-3984-7791

FAX : 81-3-3971-0535

E-mail : adapter@sunhayato.co.jp

3. Memory Space

Memory space in each mode, such as 32-Kbyte PROM, option area is diagrammed below.

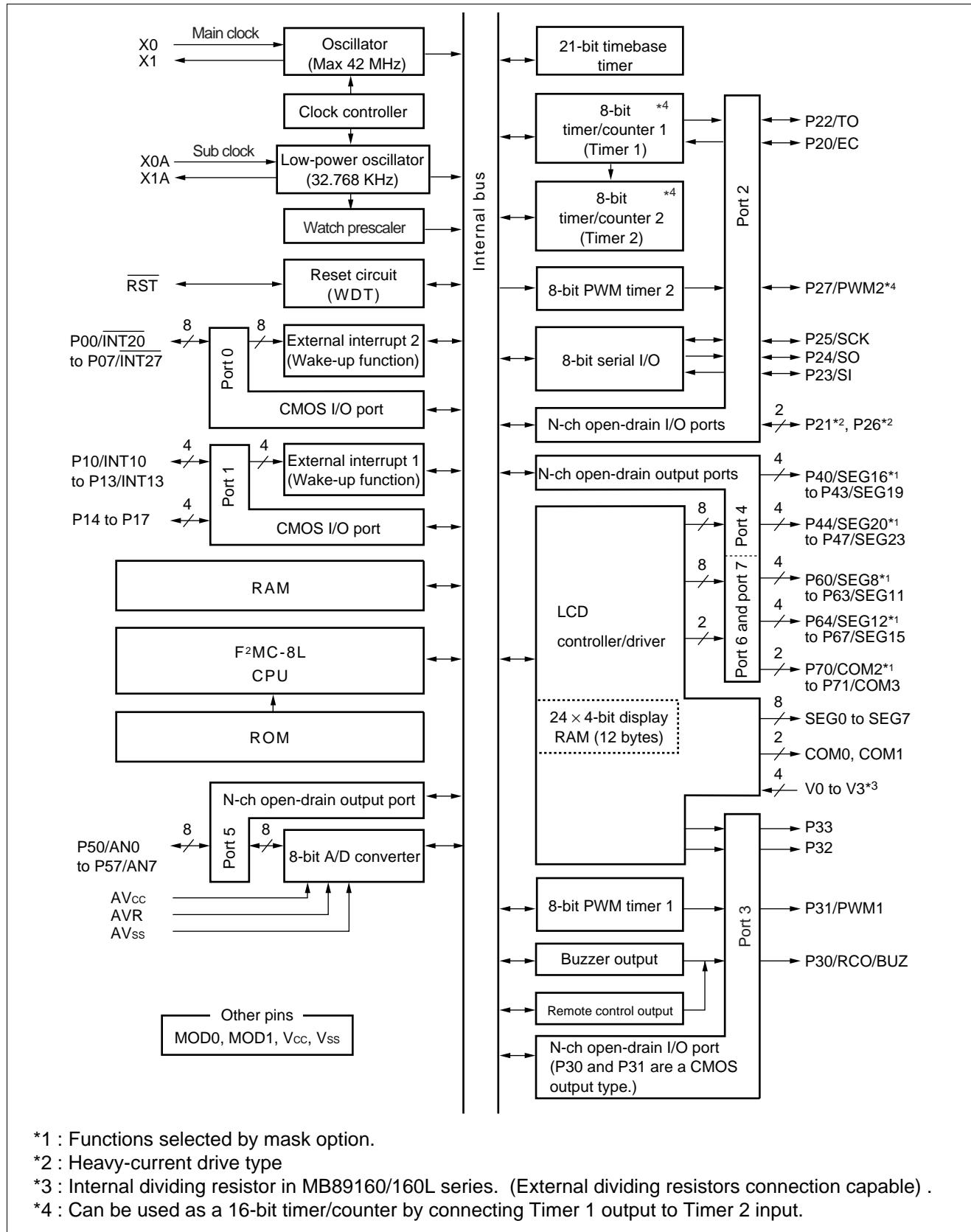


4. Programming to the EPROM

- (1) Set the EPROM programmer to the MBM27C256A.
- (2) Load program data into the EPROM programmer at 0000_H to 7FFF_H.
- (3) Program to 0000_H to 7FFF_H with the EPROM programmer.

MB89160L Series

■ BLOCK DIAGRAM

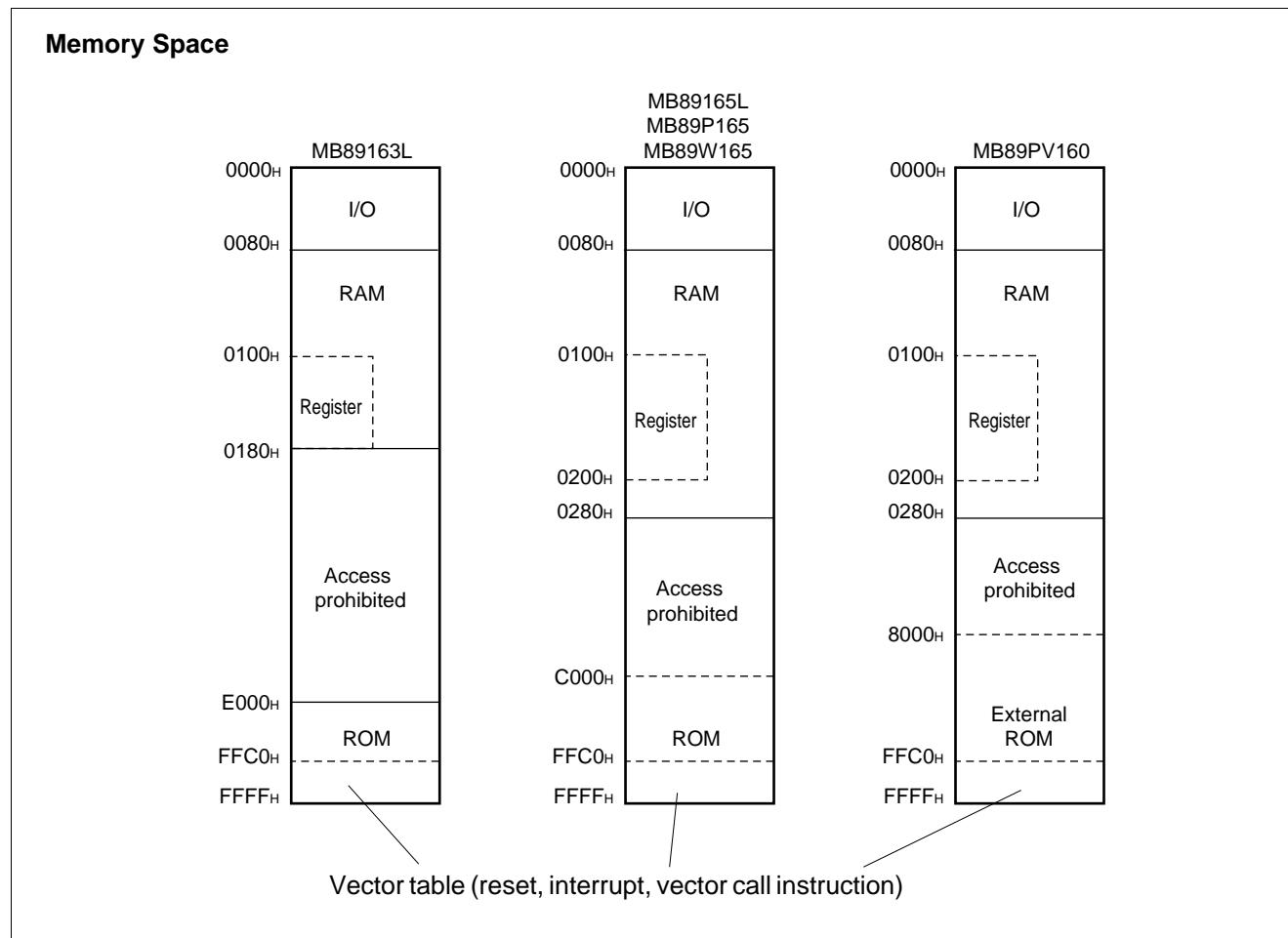


MB89160L Series

■ CPU CORE

1. Memory Space

The microcontrollers of the MB89160L series offer a memory space of 64 Kbytes for storing all of I/O, data, and program areas. The I/O area is located at the lowest address. The data area is provided immediately above the I/O area. The data area can be divided into register, stack, and direct areas according to the application. The program area is located at exactly the opposite end, that is, near the highest address. Provide the tables of interrupt reset vectors and vector call instructions toward the highest address within the program area. The memory space of the MB89160L series is structured as illustrated below.



MB89160L Series

2. Registers

The F²MC-8L family has two types of registers; dedicated registers in the CPU and general-purpose registers in the memory. The following dedicated registers are provided:

Program counter (PC): A 16-bit register for indicating instruction storage positions

Accumulator (A): A 16-bit temporary register for storing arithmetic operations, etc. When the instruction is an 8-bit data processing instruction, the lower byte is used.

Temporary accumulator (T): A 16-bit register which performs arithmetic operations with the accumulator
When the instruction is an 18-bit data processing instruction, the lower byte is used.

Index register (IX): A 16-bit register for index modification

Extra pointer (EP): A 16-bit pointer for indicating a memory address

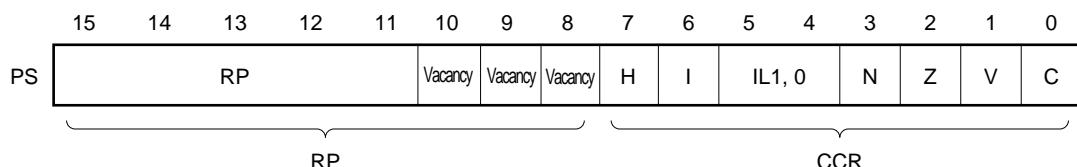
Stack pointer (SP): A 16-bit register for indicating a stack area

Program status (PS): A 16-bit register for storing a register pointer, a condition code

16 bits		Initial value
PC	: Program counter	FFF _D H
A	: Accumulator	Undefined
T	: Temporary accumulator	Undefined
IX	: Index register	Undefined
EP	: Extra pointer	Undefined
SP	: Stack pointer	Undefined
PS	: Program status	I-flag = 0, IL1, 0 = 11 Other bits are undefined.

The PS can further be divided into higher 8 bits for use as a register bank pointer (RP) and the lower 8 bits for use as a condition code register (CCR). (See the diagram below.)

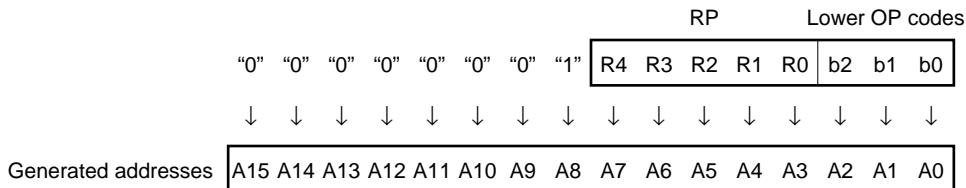
Structure of the Program Status Register



MB89160L Series

The RP indicates the address of the register bank currently in use. The relationship between the pointer contents and the actual address is based on the conversion rule illustrated below.

Rule for Conversion of Actual Addresses of the General-purpose Register Area



The CCR consists of bits indicating the results of arithmetic operations and the contents of transfer data and bits for control of CPU operations at the time of an interrupt.

H-flag: Set when a carry or a borrow from bit 3 to bit 4 occurs as a result of an arithmetic operation. Cleared otherwise. This flag is for decimal adjustment instructions.

I-flag: Interrupt is allowed when this flag is set to 1. Interrupt is prohibited when the flag is set to 0. Set to 0 when reset.

IL1, 0: Indicates the level of the interrupt currently allowed. Processes an interrupt only if its request level is higher than the value indicated by this bit.

IL1	IL0	Interrupt level	High-low
0	0	1	High
0	1		
1	0	2	
1	1	3	Low = no interrupt

N-flag: Set if the MSB is set to 1 as the result of an arithmetic operation. Cleared when the bit is set to 0.

Z-flag: Set when an arithmetic operation results in 0. Cleared otherwise.

V-flag: Set if the complement on 2 overflows as a result of an arithmetic operation. Reset if the overflow does not occur.

C-flag: Set when a carry or a borrow from bit 7 occurs as a result of an arithmetic operation. Cleared otherwise. Set the shift-out value in the case of a shift instruction.

MB89160L Series

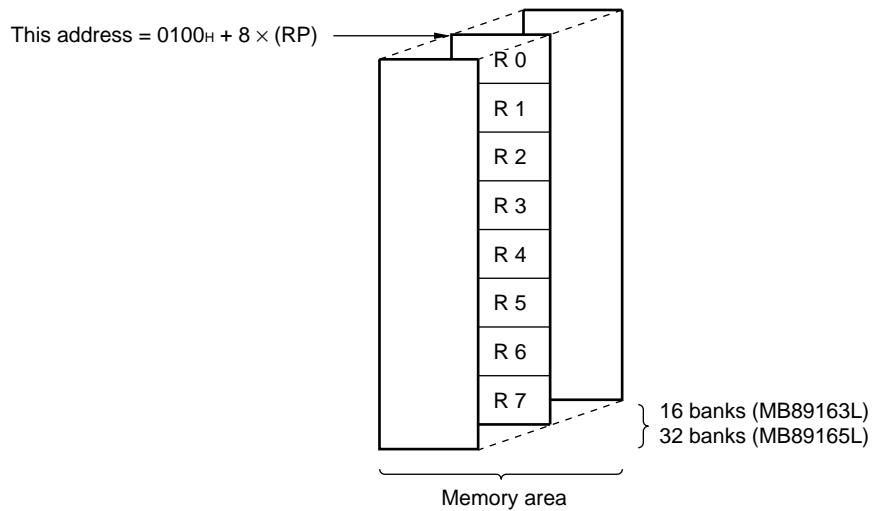
The following general-purpose registers are provided:

General-purpose registers: An 8-bit register for storing data

The general-purpose registers are 8 bits and located in the register banks of the memory. One bank contains eight registers. Up to a total of 16 banks can be used on the MB89163L (RAM 256×8 bits), and a total of 32 banks can be used on the MB89165L, MB89P165/W165, MB89PV160 (RAM 512×8 bits). The bank currently in use is indicated by the register bank pointer (RP).

Note : The number of register banks that can be used varies with the RAM size.

Register Bank Configuration



MB89160L Series

■ I/O MAP

Address	Read/write	Register name	Register description
00 _H	(R/W)	PDR0	Port 0 data register
01 _H	(W)	DDR0	Port 0 data direction register
02 _H	(R/W)	PDR1	Port 1 data register
03 _H	(W)	DDR1	Port 1 data direction register
04 _H	(R/W)	PDR2	Port 2 data register
05 _H	(W)	DDR2	Port 2 data direction register
06 _H			Vacancy
07 _H	(R/W)	SYCC	System clock control register
08 _H	(R/W)	STBC	Standby control register
09 _H	(R/W)	WDTC	Watchdog timer control register
0A _H	(R/W)	TBTC	Time-base timer control register
0B _H	(R/W)	WPCR	Watch prescaler control register
0C _H	(R/W)	PDR3	Port 3 data register
0D _H			Vacancy
0E _H	(R/W)	PDR4	Port 4 data register
0F _H	(R/W)	PDR5	Port 5 data register
10 _H	(R/W)	BUZR	Buzzer register
11 _H			Vacancy
12 _H	(R/W)	PDR6	Port 6 data register
13 _H	(R/W)	PDR7	Port 7 data register
14 _H	(R/W)	RCR1	Remote control transmission register 1
15 _H	(R/W)	RCR2	Remote control transmission register 2
16 _H			Vacancy
17 _H			Vacancy
18 _H	(R/W)	T2CR	Timer 2 control register
19 _H	(R/W)	T1CR	Timer 1 control register
1A _H	(R/W)	T2DR	Timer 2 data register
1B _H	(R/W)	T1DR	Timer 1 data register
1C _H	(R/W)	SMR	Serial mode register
1D _H	(R/W)	SDR	Serial data register
1E _H	(R/W)	CNTR1	PWM 1 control register
1F _H	(W)	COMR1	PWM 1 compare register

(Continued)

MB89160L Series

(Continued)

Address	Read/write	Register name	Register description
20 _H	(R/W)	CNTR2	PWM 2 control register
21 _H	(W)	COMR2	PWM 2 compare register
22 _H to 2C _H			Vacancy
2D _H	(R/W)	ADC1	A/D converter control register 1
2E _H	(R/W)	ADC2	A/D converter control register 2
2F _H	(R/W)	ADCD	A/D converter data register
30 _H	(R/W)	EIE1	External interrupt 1 enable register 1
31 _H	(R/W)	EIF1	External interrupt 1 flag register 1
32 _H	(R/W)	EIE2	External interrupt 2 enable register 2
33 _H	(R/W)	EIF2	External interrupt 2 flag register 2
34 _H to 5F _H			Vacancy
60 _H to 6B _H	(R/W)	VRAM	Display data RAM
6C _H to 71 _H			Vacancy
72 _H	(R/W)	LCDR	LCD controller/driver control register 1
73 _H to 7B _H			Vacancy
7C _H	(W)	ILR1	Interrupt level setting register 1
7D _H	(W)	ILR2	Interrupt level setting register 2
7E _H	(W)	ILR3	Interrupt level setting register 3
7F _H	Access prohibited	ITR	Interrupt test register

Note : Do not use vacancies.

MB89160L Series

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

(AV_{SS} = V_{SS} = 0.0 V)

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage	V _{CC} , AV _{CC} , AVR	V _{SS} - 0.3	V _{SS} + 4.0	V	For MB89163L/165L AV _{CC} must not exceed V _{CC} + 0.3 V. AVR must not exceed AV _{CC} + 0.3 V.
		V _{SS} - 0.3	V _{SS} + 7.0	V	For MB89PV160/P165/W165 AV _{CC} must not exceed V _{CC} + 0.3 V. AVR must not exceed AV _{CC} + 0.3 V.
LCD power supply voltage	V ₀ to V ₃	V _{SS} - 0.3	V _{SS} + 4.0	V	For MB89163L/165L V ₀ to V ₃ must not exceed V _{CC} .
		V _{SS} - 0.3	V _{SS} + 7.0	V	For MB89PV160/P165/W165 V ₀ to V ₃ must not exceed V _{CC} .
Input voltage	V _{I1}	V _{SS} - 0.3	V _{CC} + 0.3	V	V _{I1} must not exceed V _{SS} + 4.0 V for MB89163L/165L and V _{SS} + 7.0 V for MB89PV160/P165/W165. All pins except P20 to P27 without a pull-up resistor.
	V _{I2}	V _{SS} - 0.3	V _{CC} + 4.0	V	P20 to P27 without a pull-up resistor for MB89163L/165L
		V _{SS} - 0.3	V _{SS} + 7.0		P20 to P27 without a pull-up resistor for MB89PV160/P165/W165
Output voltage	V _{O1}	V _{SS} - 0.3	V _{CC} + 0.3	V	V _{O1} must not exceed V _{SS} + 4.0 V for MB89163L/165L and V _{SS} + 7.0 V for MB89PV160/P165/W165. All pins except P20 to P27, P32, P33, P40 to P47, and P60 to P67 without a pull-up resistor.
	V _{O2}	V _{SS} - 0.3	V _{SS} + 4.0	V	P20 to P27, P32, P33, P40 to P47, and P60 to P67 without a pull-up resistor for MB89163L/165L
		V _{SS} - 0.3	V _{SS} + 7.0	V	P20 to P27, P32, P33, P40 to P47, and P60 to P67 without a pull-up resistor for MB89PV160/P165/W165
"L" level maximum output current	I _{OL1}	—	10	mA	All pins except P21, P26, and P27
	I _{OL2}	—	20	mA	P21, P26, and P27
"L" level average output current	I _{OLAV1}	—	4	mA	All pins except P21, P26, P27, and power supply pins Average value (operating current × operating rate)
	I _{OLAV2}	—	8	mA	P21, P26, and P27 Average value (operating current × operating rate)

(Continued)

MB89160L Series

(Continued)

(AV_{SS} = V_{SS} = 0.0 V)

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
"L" level total maximum output current	ΣI_{OL}	—	100	mA	Peak value
"L" level total average output current	ΣI_{OLAV}	—	40	mA	Average value (operating current × operating rate)
"H" level maximum output current	I_{OH1}	—	-5	mA	All pins except P30, P31, and power supply pins
	I_{OH2}	—	-10	mA	P30 and P31
"H" level average output current	I_{OHAV1}	—	-2	mA	All pins except P30, P31, and power supply pins Average value (operating current × operating rate)
	I_{OHAV2}	—	-4	mA	P30 and P31 Average value (operating current × operating rate)
"H" level total maximum output current	ΣI_{OH}	—	-50	mA	Peak value
"H" level total average output current	ΣI_{OHAV}	—	-10	mA	Average value (operating current × operating rate)
Power consumption	P_D	—	300	mW	
Operating temperature	T _a	-40	+85	°C	
Storage temperature	T _{stg}	-55	+150	°C	

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

MB89160L Series

2. Recommended Operating Conditions

(AV_{SS} = V_{SS} = 0.0 V)

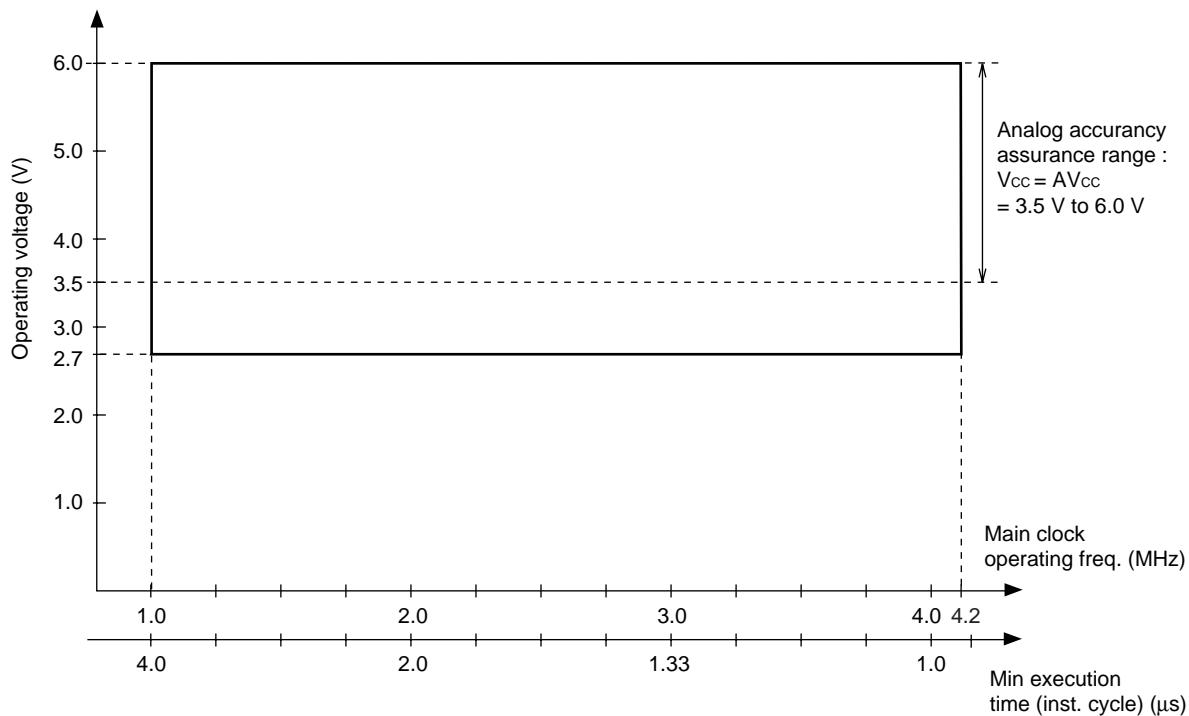
Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
Power supply voltage	V _{CC} , AV _{CC}	2.2*	3.6*	V	Normal operation assurance range* for MB89163L/165L
		2.7	6.0	V	Normal operation assurance range for MB89PV160 and MB89P165/W165
		1.5	3.6	V	Retains the RAM state in stop mode for MB89163L/165L
		1.5	6.0	V	Retains the RAM state in stop mode for MB89PV160 and MB89P165/W165
	AVR	2.0	AV _{CC}	V	Normal operation assurance range
LCD power supply voltage	V ₀ to V ₃	V _{SS}	V _{CC}	V	V ₀ to V ₃ LCD power supply range (The optimum value dependent on the LCD element in use.)
EPROM program power supply voltage	V _{PP}	—	V _{SS} + 13.0	V	MOD1 pin of the MB89P165/W165
Operating temperature	T _a	-40	+85	°C	

* : The minimum operating power supply voltage varies with the execution time (instruction cycle time) setting for the operating frequency.

A/D converter assurance accuracy varies with the operating power supply voltage.

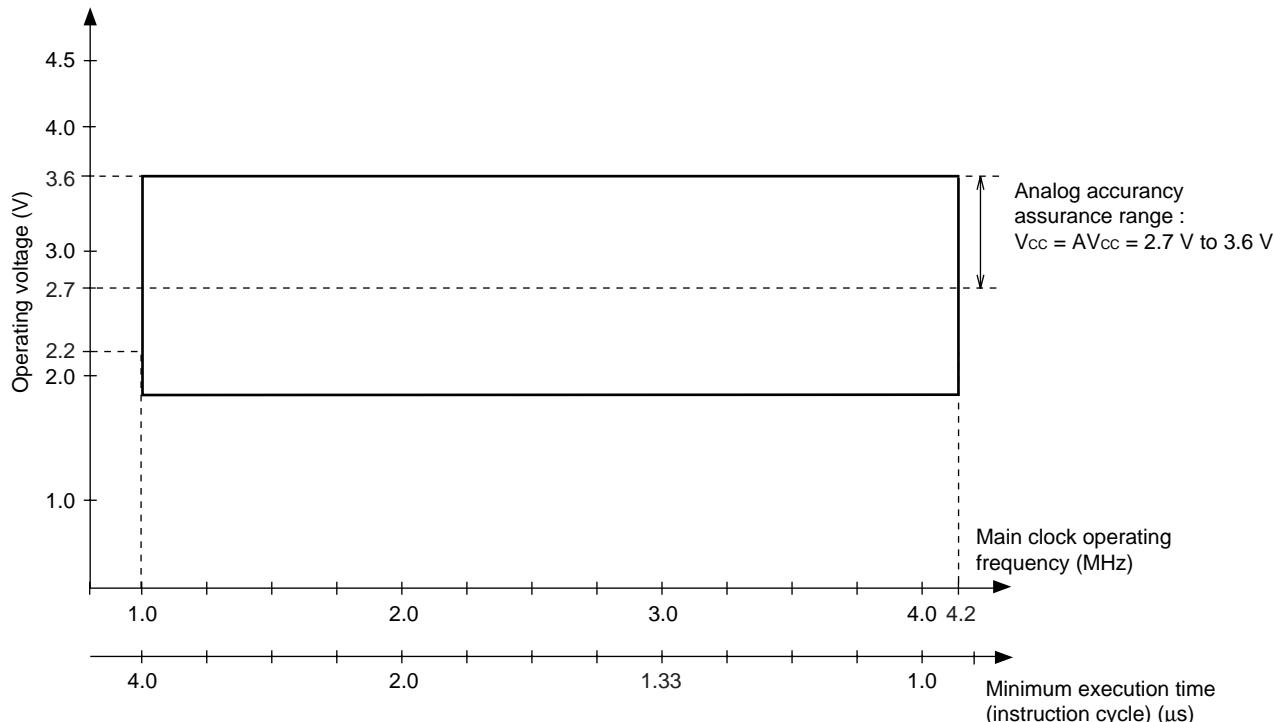
MB89160L Series

Operating Voltage vs. Main Clock Operating Frequency (MB89PV160/P165/W165)



MB89160L Series

Operating Voltage vs. Main Clock Operating Frequency (MB89163L/165L)



"Operating Voltage vs. Main Clock Operating Frequency (MB89PV160/P165/W165) and (MB89163L/165L)" indicate the operating frequency of the external oscillator at an instruction cycle of $4/F_{CH}$.

Since the operating voltage range is dependent on the instruction cycle, see minimum execution time if the operating speed is switched using a gear.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

MB89160L Series

3. DC Characteristics

(1) Pin DC characteristics ($V_{CC} = +3.0$ V for MB89163L/165L ; $+5.0$ V for MB89PV160/P165/W165)

($V_{SS} = 0.0$ V, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
"H" level input voltage	V_{IH}	P00 to P07, P10 to P17, P20 to P27	—	0.7 V_{CC}	—	$V_{CC} + 0.3$	V	
	V_{IHS}	\overline{RST} , MOD0, MOD1, EC, SI, SCK, INT10 to INT13, INT20 to INT27		0.8 V_{CC}	—	$V_{CC} + 0.3$	V	
"L" level input voltage	V_{IL}	P00 to P07, P10 to P17, P20 to P27	—	$V_{SS} - 0.3$	—	0.3 V_{CC}	V	
	V_{ILS}	\overline{RST} , MOD0, MOD1, EC, SI, SCK, INT10 to INT13, INT20 to INT27		$V_{SS} - 0.3$	—	0.2 V_{CC}	V	
Open-drain output pin application voltage	V_{D1}	P20 to P27, P33, P32, P40 to P47, P60 to P67	—	$V_{SS} - 0.3$	—	$V_{SS} + 4.0$	V	For MB89163L/165L, P20 to P27, P40 to P47 and P60 to P67 without pull-up resistor only
				$V_{SS} - 0.3$	—	$V_{SS} + 6.0$	V	For MB89PV160/P165/W165, P20 to P27, P40 to P47 and P60 to P67 without pull-up resistor only
	V_{D2}	P50 to P57		$V_{SS} - 0.3$	—	$V_{CC} + 0.3$	V	
"H" level output voltage	V_{OH1}	P00 to P07, P10 to P17	$I_{OH} = -2.0$ mA	2.2	—	—	V	MB89163L/165L
			$I_{OH} = -2.0$ mA	2.4	—	—	V	MB89PV160/P165/W165
	V_{OH2}	P30, P31	$I_{OH} = -8.0$ mA	2.2	—	—	V	MB89163L/165L
			$I_{OH} = -6.0$ mA	4.0	—	—	V	MB89PV160/P165/W165
"L" level output voltage	V_{OL}	P00 to P07, P10 to P17, P20, P20 to P25, P30 to P33, P40 to P47, P50 to P57, P60 to P67, P70, P71	$I_{OL} = 1.8$ mA	—	—	0.4	V	

(Continued)

MB89160L Series

(Continued)

($V_{SS} = 0.0$ V, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
"L" level output voltage	V_{OL2}	P21, P26, P27	$I_{OL} = 8.0$ mA	—	—	0.4	V	
	V_{OL3}	RST	$I_{OL} = 4.0$ mA	—	—	0.4	V	MB89163L/165L
			$I_{OL} = 4.0$ mA	—	—	0.6	V	MB89PV160/P165/W165
Input leakage current (High-Z output leakage current)	I_{IU1}	P00 to P07, P10 to P17, MOD0, MOD1, P30, P31	$0.45 \text{ V} < V_I < V_{CC}$	—	—	± 5	μA	Without pull-up resistor
Open-drain output leakage current	I_{LO1}	P20 to P27, P32, P33, P40 to P47, P60 to P67, P70, P71	$0.45 \text{ V} < V_I < 4.0 \text{ V}$	—	—	± 5	μA	Without pull-up resistor for MB89163L/165L
			$0.45 \text{ V} < V_I < 6.0 \text{ V}$	—	—	± 5	μA	Without pull-up resistor for MB89PV160/P165/W165
	I_{LO2}	P50 to P57	$0.45 \text{ V} < V_I < V_{CC}$	—	—	± 5	μA	Without pull-up resistor
Pull-up resistance	R_{PULL}	P00 to P07, P10 to P17, P20 to P27, P40 to P47, P50 to P57, P60 to P67, RST	$V_I = 0.0$ V	25	50	100	$\text{k}\Omega$	With pull-up resistor
Common output impedance	R_{VCOM}	COM0 to COM3	V_1 to $V_3 = +3.0$ V	—	—	2.5	$\text{k}\Omega$	MB89163L/165L
			V_1 to $V_3 = +5.0$ V	—	—	2.5	$\text{k}\Omega$	MB89PV160/P165/W165
Segment output impedance	R_{VSEG}	SEG0 to SEG23	V_1 to $V_3 = +3.0$ V	—	—	15	$\text{k}\Omega$	MB89163L/165L
			V_1 to $V_3 = +5.0$ V	—	—	15	$\text{k}\Omega$	MB89PV160/P165/W165
LCD divided resistance	R_{LCD}	—	Between V_{CC} and V_0	300	500	750	$\text{k}\Omega$	
LCD controller/driver leakage current	I_{LCDL}	V0 to V3, COM0 to COM3, SEG0 to SEG23	—	—	—	± 1	μA	
Input capacitance	C_{IN}	Other than V_{CC} , V_{SS}	$f = 1$ MHz	—	10	—	pF	

Note : For pins which serve as the segment (SEG8 to SEG23) and ports (P40 to P47 and P60 to P67), see the port parameter when these pins are used as ports and the segment parameter when they are used as segments.

MB89160L Series

(2) Pin DC Characteristics ($V_{CC} = +3.0$ V for MB89163L/165L, MB89PV160, MB89P165/W165)

($V_{SS} = 0.0$ V, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
"H" level output voltage	V_{OH1}	P00 to P07, P10 to P17	$I_{OH} = -2.0$ mA	2.2	—	—	V	MB89163L/ 165L
			$I_{OH} = -1.0$ mA	2.4	—	—	V	MB89PV160/ P165/W165
	V_{OH2}	P30, P31	$I_{OH} = -8.0$ mA	2.2	—	—	V	MB89163L/ 165L
			$I_{OH} = -3.0$ mA	2.4	—	—	V	MB89PV160/ P165/W165
"L" level output voltage	V_{OL}	P00 to P07, P10 to P17, P20, P22 to P27, P30 to P33, P40 to P47, P50 to P57, P60 to P67, P70, P71	$I_{OL} = 4.0$ mA	—	—	0.4	V	MB89163L/ 165L
			$I_{OL} = 1.8$ mA	—	—	0.4	V	MB89PV160/ P165/W165
	V_{OL2}	\overline{RST}	$I_{OL} = 4.0$ mA	—	—	0.4	V	MB89163L/ 165L
			$I_{OL} = 1.8$ mA	—	—	0.4	V	MB89PV160/ P165/W165
	V_{OL3}	P21, P26, P27	$I_{OL} = 8.0$ mA	—	—	0.4	V	MB89163L/ 165L
			$I_{OL} = 3.6$ mA	—	—	0.4	V	MB89PV160/ P165/W165
Pull-up resistance	R_{PULL}	P00 to P07, P10 to P17, P20 to P27, P40 to P47, P50 to P57, P60 to P67, \overline{RST}	$V_I = 0.0$ V	50	100	150	$k\Omega$	With pull-up resistor for MB89163L/ 165L
				25	50	100	$k\Omega$	Without pull- up resistor for MB89PV160/ P165/W165

MB89160L Series

(3) Power Supply Current Characteristics (MB8916X)

($V_{SS} = 0.0 \text{ V}$, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks	
				Min	Typ	Max			
Power supply current ^{*1}	I _{CC1}	V _{CC}	$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 4/F_{CH}$ Main clock operation mode	—	1.0	2.5	mA	MB89163L/165L	
			$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 5.0 \text{ V}$ $t_{inst}^{*2} = 4/F_{CH}$ Main clock operation mode	—	5.0	10.0	mA	MB89PV160	
			$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 64/F_{CH}$ Main clock operation mode	—	8.0	15.0	mA	MB89P165/W165	
	I _{CC2}		$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 64/F_{CH}$ Main clock operation mode	—	0.6	2.0	mA	MB89163L/165L	
			$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 64/F_{CH}$ Main clock operation mode	—	1.5	2.0	mA	MB89PV160	
			$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 64/F_{CH}$ Main clock operation mode	—	2.4	2.8	mA	MB89P165/W165	
	I _{CC3}		$F_{CL} = 32.768 \text{ kHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 2/F_{CL}$, $T_a = +25^\circ\text{C}$ Subclock operation mode	—	0.02	0.1	mA	MB89163L/165L	
			$F_{CL} = 32.768 \text{ kHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 2/F_{CL}$, $T_a = +25^\circ\text{C}$ Subclock operation mode	—	0.05	0.1	mA	MB89PV160	
			$F_{CL} = 32.768 \text{ kHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 2/F_{CL}$, $T_a = +25^\circ\text{C}$ Subclock operation mode	—	1.0	3.0	mA	MB89P165/W165	
	I _{CCS1}		$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 4/F_{CH}$ Main clock sleep mode	—	0.3	2.0	mA	MB89163L/165L	
			$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 5.0 \text{ V}$ $t_{inst}^{*2} = 4/F_{CH}$ Main clock sleep mode	—	2.5	5.0	mA	MB89PV160, MB89P165/W165	
	I _{CCS2}		$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 64/F_{CH}$ Main clock sleep mode	—	0.2	1.5	mA	MB89163L/165L	
			$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 64/F_{CH}$ Main clock sleep mode	—	1.0	1.5	mA	MB89PV160, MB89P165/W165	
	I _{CCSL}		$F_{CL} = 32.768 \text{ kHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 2/F_{CL}$ Subclock sleep mode $T_a = +25^\circ\text{C}$	—	4.0	50	μA	MB89163L/165L	
			$F_{CL} = 32.768 \text{ kHz}$, $V_{CC} = 3.0 \text{ V}$ $t_{inst}^{*2} = 2/F_{CL}$ Subclock sleep mode $T_a = +25^\circ\text{C}$	—	25	50	μA	MB89PV160, MB89P165/W165	
	I _{CC7}		$F_{CL} = 32.768 \text{ kHz}$, $V_{CC} = 3.0 \text{ V}$ Watch mode $T_a = +25^\circ\text{C}$	—	1	15	μA	MB89163L/165L	
			$F_{CL} = 32.768 \text{ kHz}$, $V_{CC} = 3.0 \text{ V}$ Watch mode $T_a = +25^\circ\text{C}$	—	10	15	μA	MB89PV160, MB89P165/W165	
	I _{CC8}		$T_a = +25^\circ\text{C}$, $V_{CC} = 3.0 \text{ V}$ Stop mode	—	0.8	10.0	μA	MB89163L/165L	
			$T_a = +25^\circ\text{C}$, $V_{CC} = 5.0 \text{ V}$ Stop mode	—	0.1	10.0	μA	MB89PV160, MB89P165/W165	
	I _A	AV _{CC}	$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 3.0 \text{ V}$ When A/D conversion is activated	—	0.6	2.0	mA	MB89163L/165L	
			$F_{CH} = 4.2 \text{ MHz}$, $V_{CC} = 5.0 \text{ V}$ When A/D conversion is activated	—	1.0	3.0	mA	MB89PV160, MB89P165/W165	

*1 : The power supply current is measured at the external clock, open output pins, and the external LCD dividing resistor (or external input for the reference voltage). In the case of the MB89PV160, the current consumed by the connected EPROM and ICE is not included.

*2 : For information on t_{inst} , see "(4) Instruction Cycle" in "4. AC Characteristics."

MB89160L Series

4. AC Characteristics

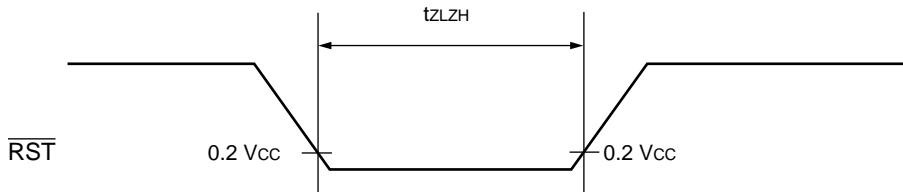
(1) Reset Timing

($V_{CC} = +3.0\text{ V} \pm 10\%$ for MB89163L/165L; $+5.0\text{ V} \pm 10\%$ for MB89PV160/P165/W165, $V_{SS} = 0.0\text{ V}$, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min	Max		
RST "L" pulse width	t_{ZLZH}	—	48 t_{HCYL}	—	ns	

Notes : • t_{HCYL} is the main clock oscillator period.

- If the reset pulse applied to the external reset pin (\overline{RST}) does not meet the specifications, it may cause malfunctions. Use caution so that the reset pulse less than the specifications will not be fed to the external reset pin (\overline{RST}).

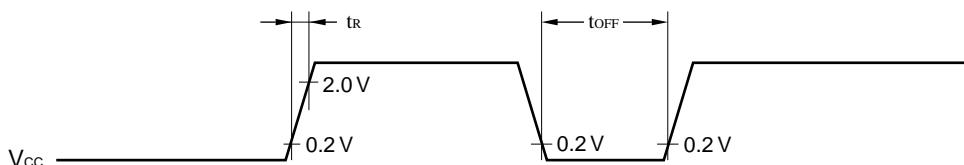


(2) Power-on Reset

($V_{SS} = 0.0\text{ V}$, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min	Max		
Power supply rising time	t_R	—	—	50	ms	Power-on reset function only
Power supply cut-off time	t_{OFF}	—	1	—	ms	Due to repeated operations

Note : Make sure that power supply rises within the selected oscillation stabilization time. If power supply voltage needs to be varied in the course of operation, a smooth voltage rise is recommended.



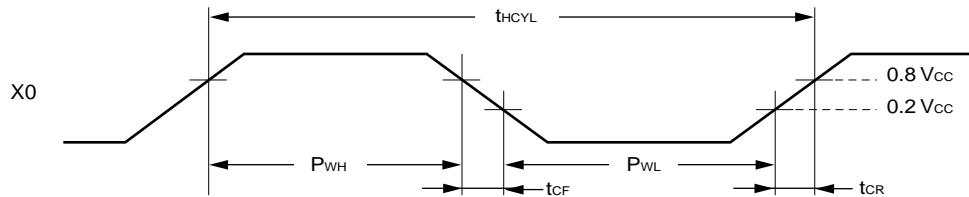
MB89160L Series

(3) Clock Timing

($V_{ss} = 0.0 \text{ V}$, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

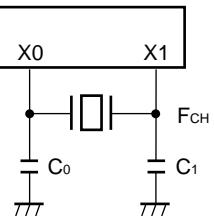
Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Clock frequency	F_{CH}	X0, X1	1	—	4.2	MHz	Main clock
	F_{CL}	X0A, X1A	—	32.768	—	kHz	Subclock
Clock cycle time	t_{HCYL}	X0, X1	238	—	1000	ns	Main clock
	t_{LCYL}	X0A, X1A	—	30.5	—	μs	Subclock
Input clock pulse width	P_{WH} P_{WL}	X0	20	—	—	ns	External clock
Input clock rising/falling time	t_{CR} t_{CF}	X0	—	—	24	ns	

Main Clock Timing and Conditions

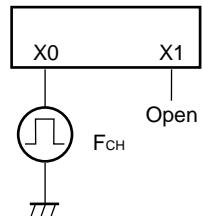


Main Clock Conditions

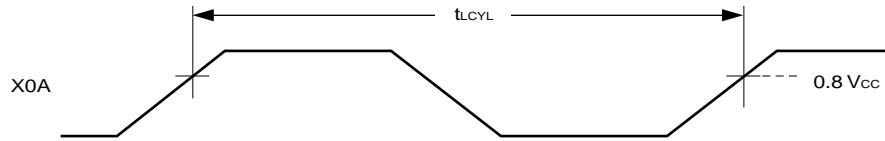
When a crystal
or
ceramic resonator is used



When an external clock is used

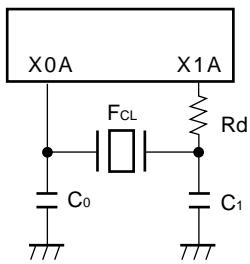


Subclock Timing and Conditions

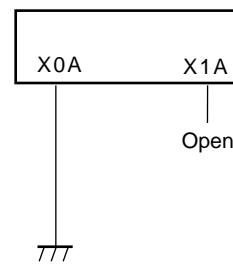


Subclock Conditions

When a crystal
or
ceramic oscillator is used



When the single-clock option is used



(4) Instruction Cycle

Parameter	Symbol	Value (typical)	Unit	Remarks
Instruction cycle (minimum execution time)	t_{inst}	$4/F_{CH}, 8/F_{CH}, 16/F_{CH},$ $64/F_{CH}$	μs	$(4/F_{CH}) t_{inst} = 1.0 \mu s$ at $F_{CH} = 4$ MHz
		$2/F_{CL}$	μs	$t_{inst} = 61.036 \mu s$ at $F_{CL} = 32.768$ kHz

MB89160L Series

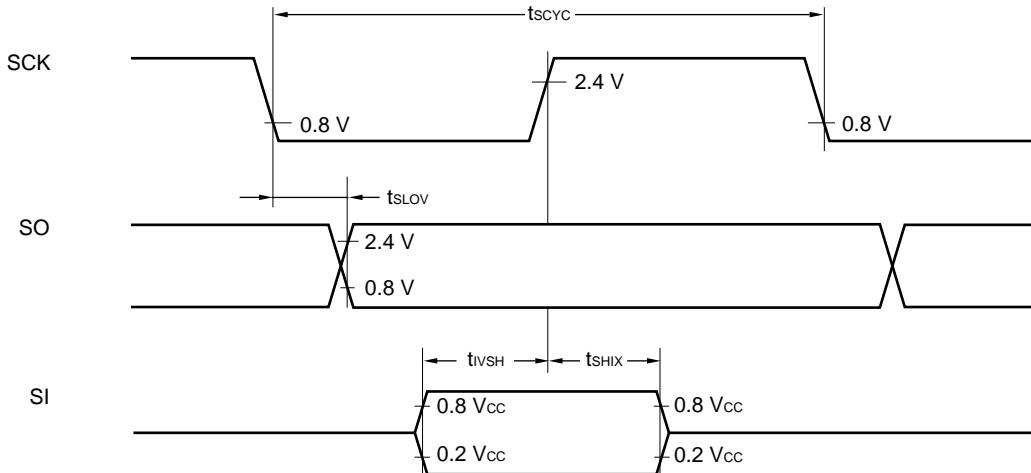
(5) Serial I/O Timing

($V_{CC} = +3.0\text{ V} \pm 10\%$ for MB89163L/165L; $+5.0\text{ V} \pm 10\%$ for MB89PV160/P165/W165, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

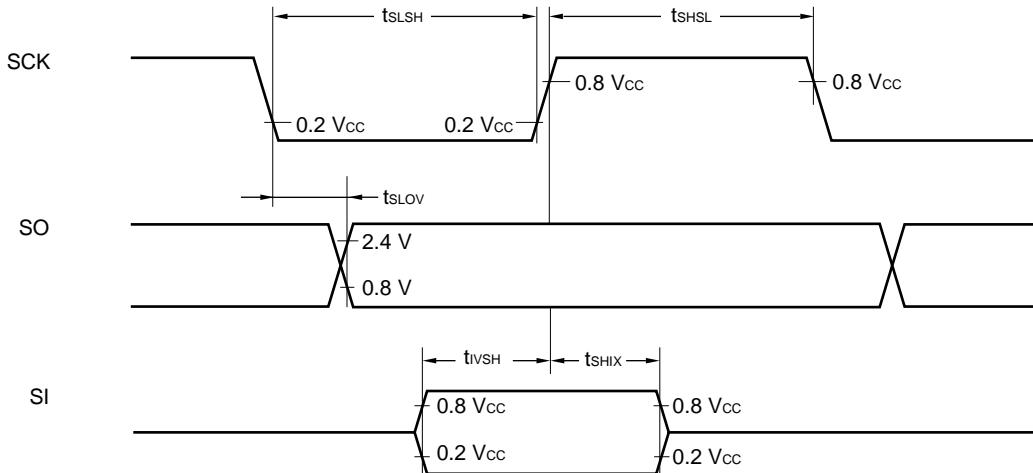
Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t _{SCYC}	SCK	Internal clock operation	2 t _{inst} *	—	μs	
SCK ↓ → SO time	t _{SLOV}	SCK, SO		-200	+200	ns	
Valid SI → SCK ↑	t _{IVSH}	SI, SCK		1/2 t _{inst} *	—	μs	
SCK ↑ → valid SI hold time	t _{SHIX}	SCK, SI		1/2 t _{inst} *	—	μs	
Serial clock "H" pulse width	t _{SHSL}	SCK	External clock operation	1 t _{inst} *	—	μs	
Serial clock "L" pulse width	t _{SLSH}			1 t _{inst} *	—	μs	
SCK ↓ → SO time	t _{SLOV}	SCK, SO		0	200	ns	
Valid SI → SCK ↑	t _{IVSH}	SI, SCK		1/2 t _{inst} *	—	μs	
SCK ↑ → valid SI hold time	t _{SHIX}	SCK, SI		1/2 t _{inst} *	—	μs	

* : For information on t_{inst}, see "(4) Instruction Cycle."

Internal Clock Operation



External Clock Operation



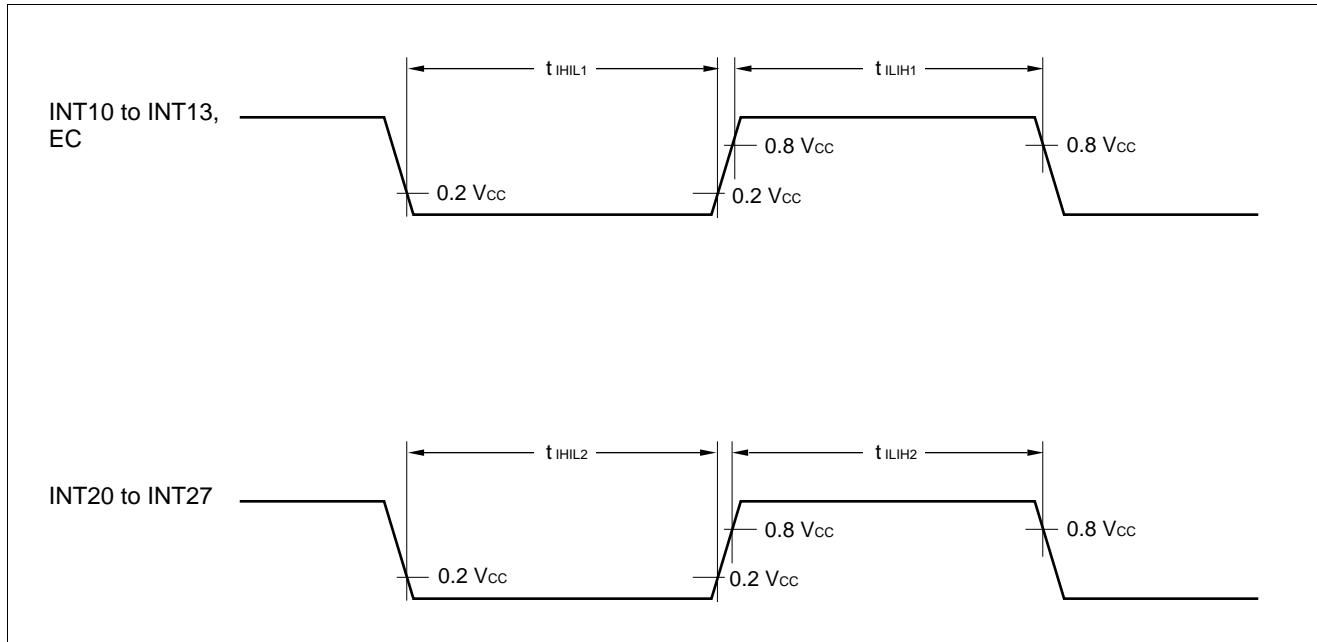
MB89160L Series

(6) Peripheral Input Timing

($V_{CC} = +3.0\text{ V} \pm 10\%$ for MB89163L/165L; $+5.0\text{ V} \pm 10\%$ for MB89PV160/P165/W165, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

Parameter	Symbol	Pin	Value		Unit	Remarks
			Min	Max		
Peripheral input "H" pulse width 1	t_{ILIH1}	INT10 to INT13, EC	1 t_{inst}^*	—	μs	
Peripheral input "L" pulse width 1	t_{IHIL1}		1 t_{inst}^*	—	μs	
Peripheral input "H" pulse width 2	t_{ILIH2}	$\overline{\text{INT20}} \text{ to } \overline{\text{INT27}}$	2 t_{inst}^*	—	μs	
Peripheral input "L" pulse width 2	t_{IHIL2}		2 t_{inst}^*	—	μs	

* : For information on t_{inst} , see "(4) Instruction Cycle."



MB89160L Series

5. A/D Converter Electrical Characteristics

(3 MHz, $AV_{CC} = V_{CC} = +2.7$ V to $+3.6$ V for MB89163L/165L; $+3.5$ V to $+6.0$ V for MB89PV160/P165/W165, $AV_{SS} = V_{SS} = 0.0$ V, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Resolution	—	—	AVR = AV_{CC}	—	—	8	bit	
Total error				—	—	± 1.5	LSB	
Linearity error				—	—	± 1.0	LSB	
Differential linearity error				—	—	± 0.9	LSB	
Zero transition voltage	V_{OT}	—	AVR = AV_{CC}	$AV_{SS} - 0.6$ LSB	$AV_{SS} + 0.9$ LSB	$AV_{SS} + 2.4$ LSB	mV	MB89163L/ 165L
Full-scale transition voltage				$AV_{SS} - 1.0$ LSB	$AV_{SS} + 0.5$ LSB	$AV_{SS} + 2.0$ LSB		MB89PV160/ P165/W165
Interchannel disparity	—	—	—	$AV_{SS} - 2.6$ LSB	$AVR + 1.1$ LSB	$AVR + 0.4$ LSB	mV	MB89163L/ 165L
A/D mode conversion time				$AVR - 3.0$ LSB	$AVR - 1.5$ LSB	AVR		MB89PV160/ P165/W165
Sense mode conversion time	—	—	—	—	—	0.5	LSB	
Analog port input current	I_{AI}	AN0 to AN7	—	—	52 t_{inst}	—	μs	MB89163L/ 165L
Analog input voltage	—			—	44 t_{inst}	—		MB89PV160/ P165/W165
				—	12 t_{inst}	—	μs	
				—	—	10	μA	
				AV_{SS}	—	AVR	V	MB89163L/ 165L
				0.0	—			MB89PV160/ P165/W165

(Continued)

MB89160L Series

(Continued)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Reference voltage	—	AVR	—	2.7	—	AV _{CC}	V	MB89163L/ 165L
				2.0	—	—		MB89PV160/ P165/W165
Reference voltage supply current	I _R	AVR	AVR = 3.0 V, when A/D conversion is activated	—	85	170	μA	MB89163L/ 165L
			AVR = 5.0 V, when A/D conversion is activated	—	100	—		MB89PV160/ P165/W165
	I _{RH}	AVR	AVR = 3.0 V, when A/D conversion is stopped	—	—	1	μA	MB89163L/ 165L
			AVR = 5.0 V, when A/D conversion is stopped	—	—	—		MB89PV160/ P165/W165

MB89160L Series

(1) A/D Glossary

- Resolution

Analog changes that are identifiable with the A/D converter.

When the number of bits is 8, analog voltage can be divided into $2^8=256$.

- Linearity error (unit: LSB)

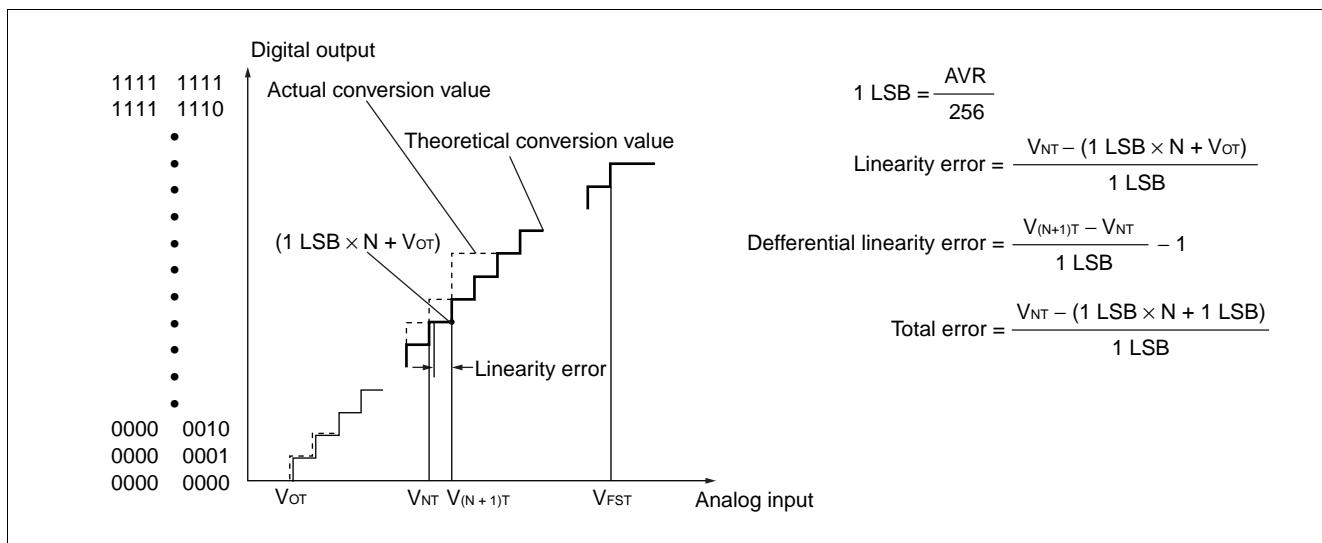
The deviation of the straight line connecting the zero transition point ("0000 0000" \leftrightarrow "0000 0001") with the full-scale transition point ("1111 1111" \leftrightarrow "1111 1110") from actual conversion characteristics

- Differential linearity error (unit: LSB)

The deviation of input voltage needed to change the output code by 1 LSB from the theoretical value

- Total error (unit: LSB)

The difference between theoretical and actual conversion values



(2) Precautions

- **Input impedance of analog input pins**

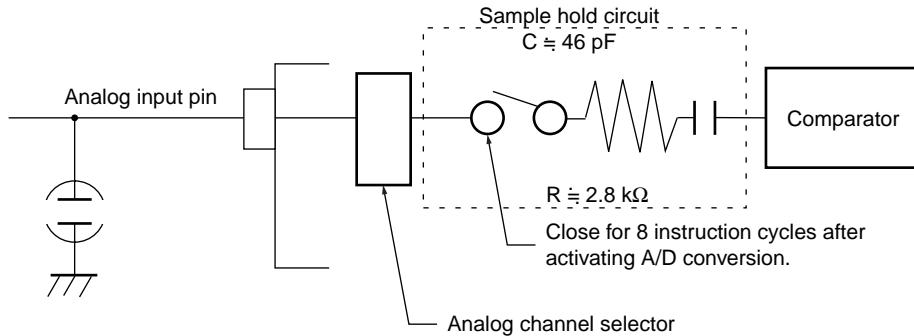
The A/D converter contains a sample hold circuit as illustrated below to fetch analog input voltage into the sample hold capacitor for eight instruction cycles after activating A/D conversion.

For this reason, if the output impedance of the external circuit for the analog input is high, analog input voltage might not stabilize within the analog input sampling period. Therefore, it is recommended to keep the output impedance of the external circuit low (below $10\text{ k}\Omega$).

Note that if the impedance cannot be kept low, it is recommended to connect an external capacitor of about $0.1\text{ }\mu\text{F}$ for the analog input pin.

Analog Input Equivalent Circuit

If the analog input impedance is higher than $10\text{ k}\Omega$, it is recommended to connect an external capacitor of approx. $0.1\text{ }\mu\text{F}$.



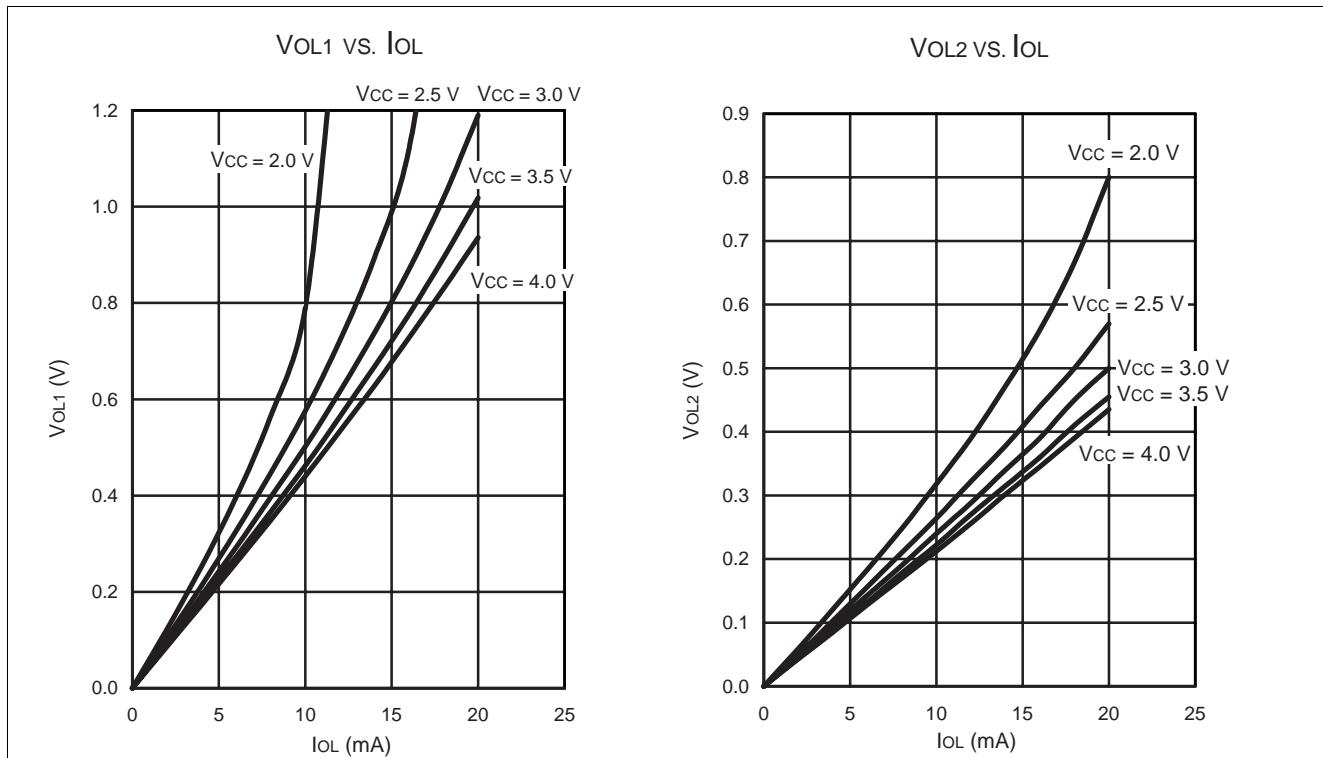
- **Error**

The smaller the $|\text{AVR} - \text{AV}_{\text{SS}}|$ is, the greater the error would become relatively.

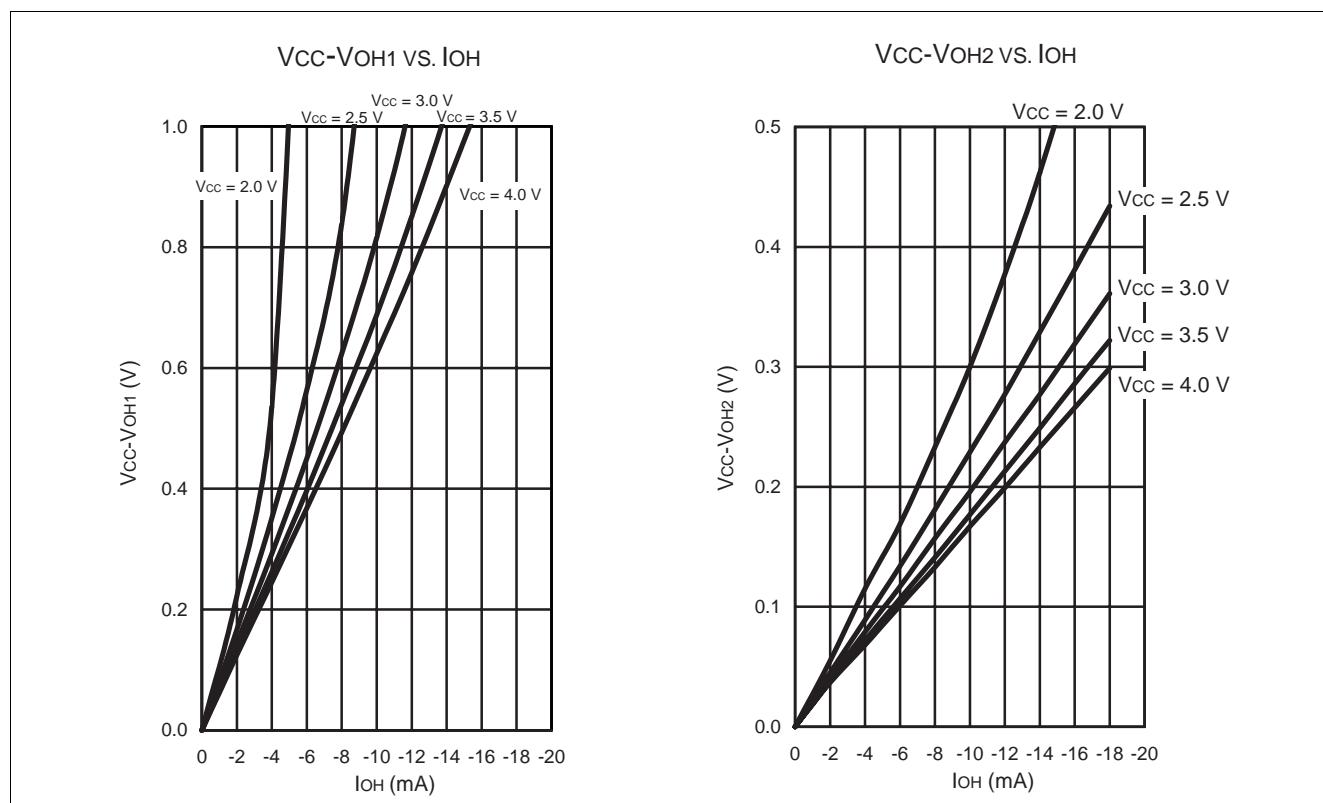
MB89160L Series

■ EXAMPLE CHARACTERISTICS

(1) "L" Level Output Voltage

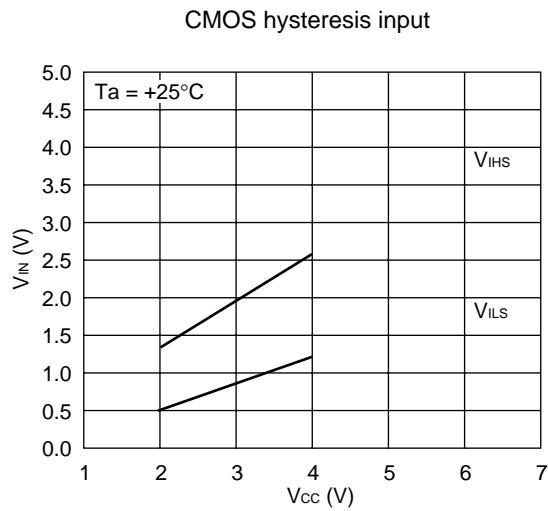
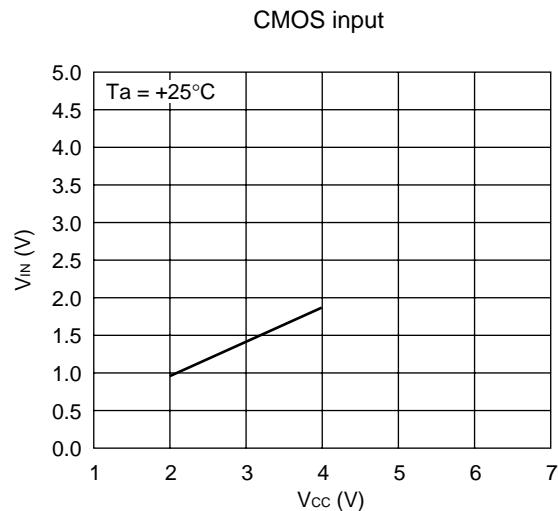


(2) "H" Level Output Voltage



MB89160L Series

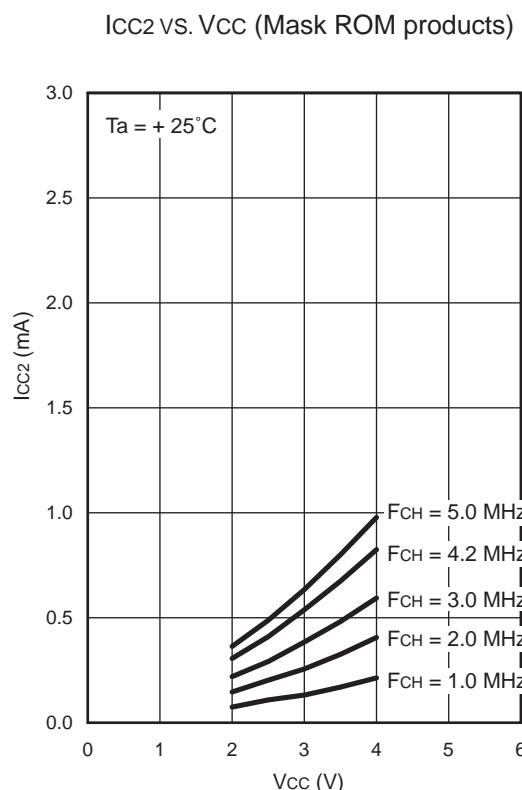
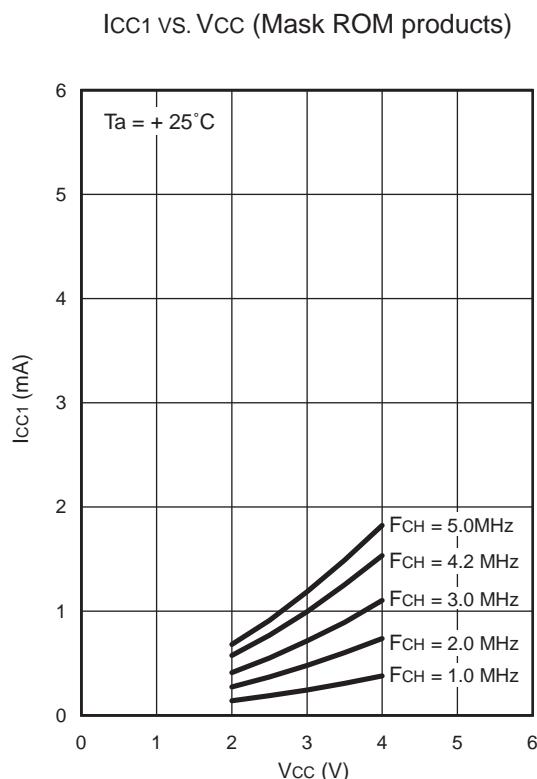
(3) "H" Level Input Voltage/"L" level Input Voltage



V_{IHS}: Threshold when input voltage in hysteresis characteristics is set to "H" level

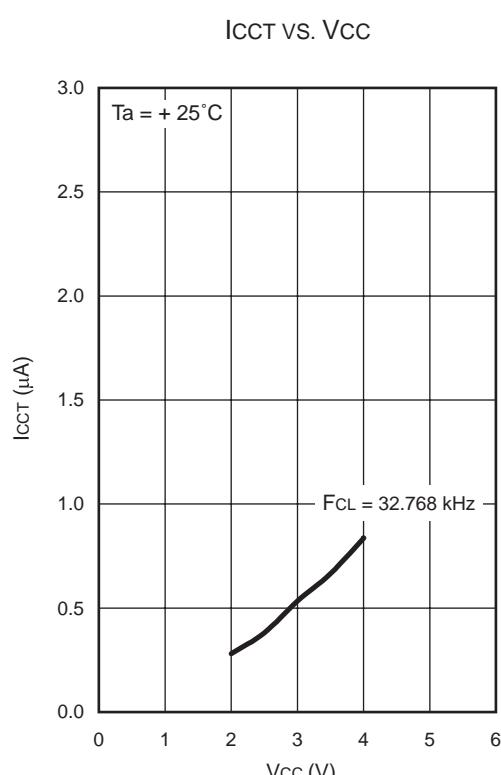
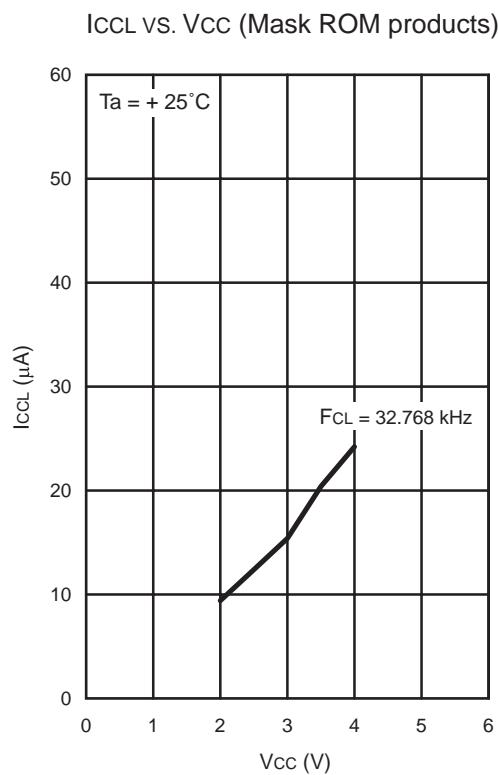
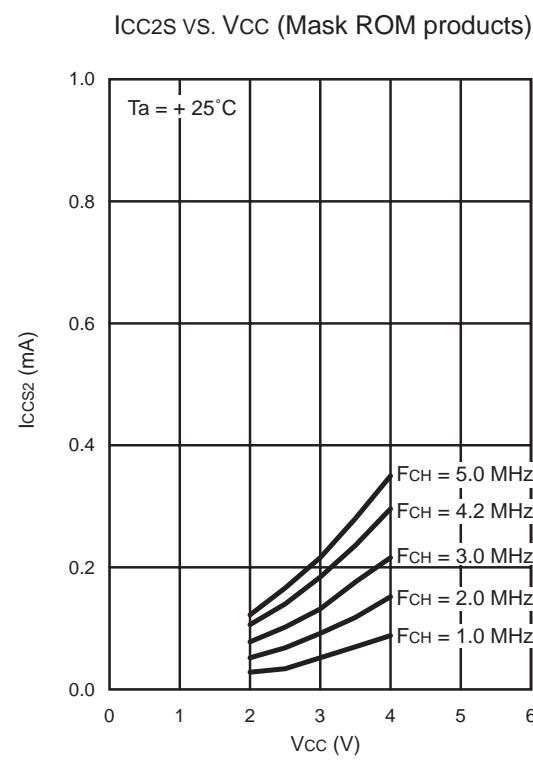
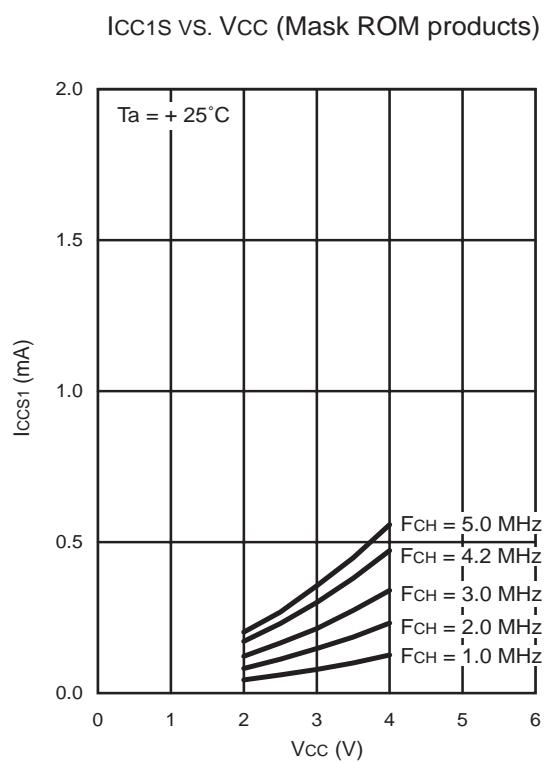
V_{ILS}: Threshold when input voltage in hysteresis characteristics is set to "L" level

(4) Power Supply Current (External Clock)



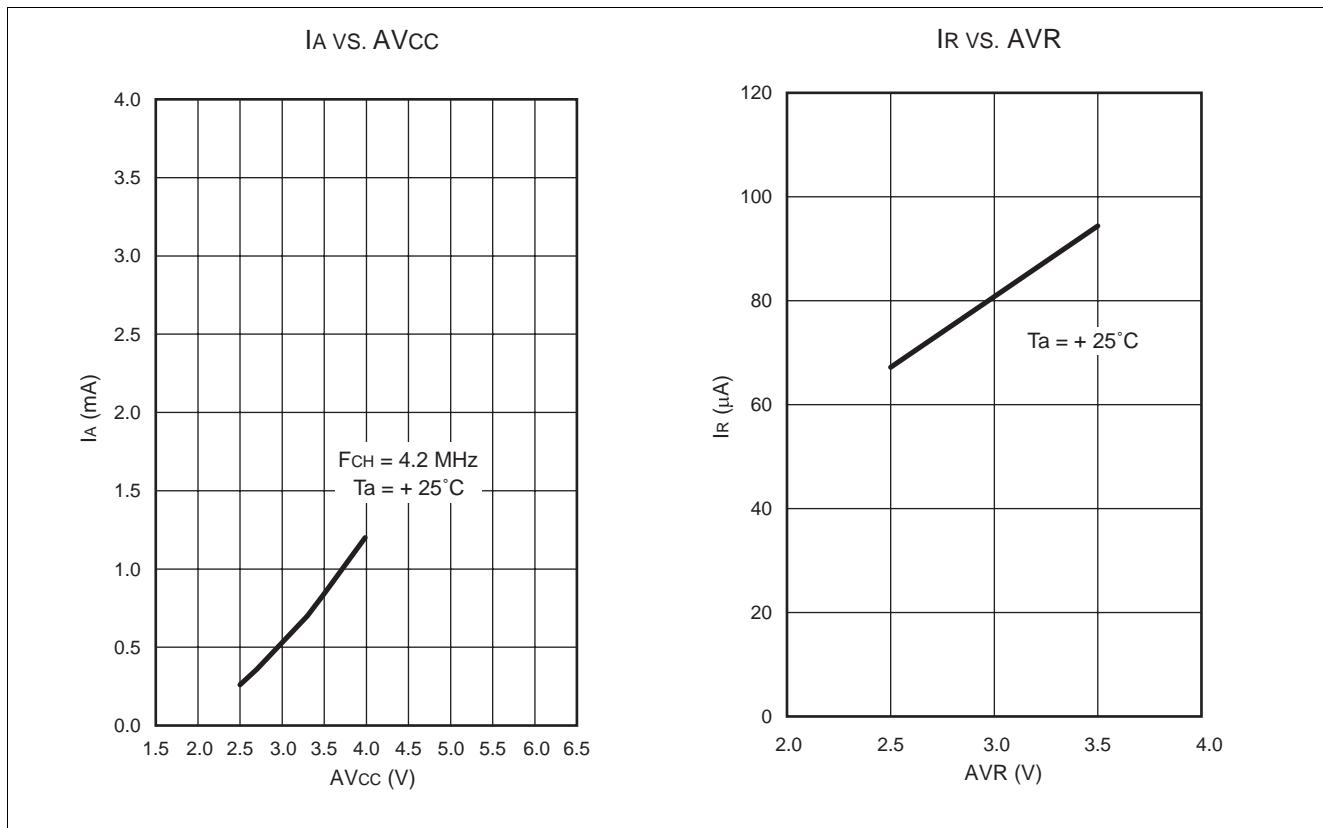
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MB89160L Series

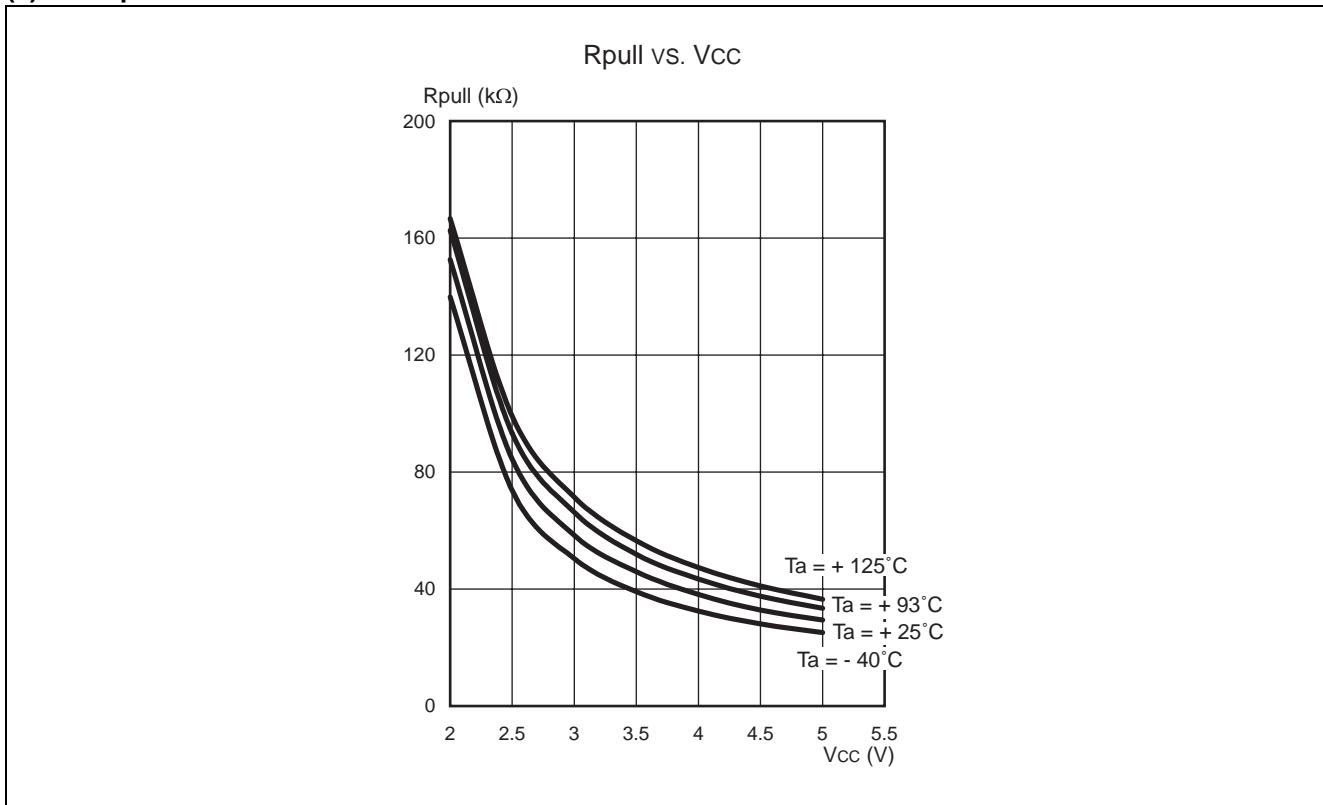


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(5) Pull-up Resistance



MB89160L Series

■ MASK OPTIONS

No.	Part number	MB89163L/165L	MB89P165/W165	MB89PV160
	Specifying procedure	Specify when ordering masking	Set with EPROM programmer	Setting not possible
1	Pull-up resistors (PXX) P00 to P07, P10 to P17, P20 to P27, P40 to P47, P50 to P57, P60 to P67	Selectable per pin (The pull-up resistors for P40 to P47 and P60 to P67 are only selectable when these pins are not set as segment outputs. When the A/D is used, P50 to P57 must not be selected.)	Can be set per pin (P20 to P27, P40 to P47, and P60 to P67 are available only for without a pull-up resistor.)	Fixed to without pull-up resistor
2	Power-on reset (POR) With power-on reset Without power-on reset	Selectable	Selectable	Fixed to with power-on reset
3	Selection of oscillation stabilization time (OSC) • The initial value of the oscillation stabilization time for the main clock can be set by selecting the values of the WTM1 and WTM0 bits on the right.	Selectable OSC 0 : $2^2/F_{CH}$ 1 : $2^{12}/F_{CH}$ 2 : $2^{16}/F_{CH}$ 3 : $2^{18}/F_{CH}$	Selectable WTM1 WTM0 0 0 : $2^2/F_{CH}$ 0 1 : $2^{12}/F_{CH}$ 1 0 : $2^{16}/F_{CH}$ 1 1 : $2^{18}/F_{CH}$	Fixed to oscillation stabilization time of $2^{16}/F_{CH}$
4	Main clock oscillation type (XSL) Crystal or ceramic resonator	Crystal or ceramic	Crystal or ceramic	Crystal or ceramic only
5	Reset pin output (RST) With reset output Without reset output	Selectable	Selectable	Fixed to with reset output
6	Clock mode selection (CLK) Dual-clock mode Single-clock mode	Selectable	Selectable	Fixed to dual-clock mode

MB89160L Series

- Segment Options

No.	Part number	MB89163L/165L	MB89P165/W165	MB89PV160
	Specifying procedure	Specify when ordering masking	Select by version number	Select by version number
7	LCD output pin configuration choices	Specify by the option combinations listed below	—	—
	SEG = 4: P40 to P47 segment output P60 to P67 segment output P70, P71 common output	Specify as SEG = 4	-101:SEG 24 pins COM 4 pins	-101:SEG 24 pins COM 4 pins
	SEG = 3: P40 to P43 segment output P44 to P47 port output P60 to P67 segment output P70, P71 common output	Specify as SEG = 3	-102:SEG 20 pins COM 4 pins	-102:SEG 20 pins COM 4 pins
	SEG = 2: P40 to P47 port output P60 to P67 segment output P70, P71 common output	Specify as SEG = 2	-103:SEG 16 pins COM 4 pins	-103:SEG 16 pins COM 4 pins
	SEG = 1: P40 to P47 port output P60 to P63 segment output P64 to P67 port output P70, P71 port output	Specify as SEG = 1	-104:SEG 12 pins COM 2 pins	-104:SEG 12 pins COM 2 pins
	SEG = 0: P40 to P47 port output P60 to P67 port output P70, P71 port output	Specify as SEG = 0	-105:SEG 8 pins COM 2 pins	-105:SEG 8 pins COM 2 pins

■ VERSIONS

Version				Features
Mass production product	One-time PROM product	EPROM product	Piggyback/evaluation product	Number of segment pins
MB89160L series	MB89P165-101 -102 -103 -104 -105	MB89W165-101 -102 -103 -104 -105	MB89PV160-101 -102 -103 -104 -105	24 (4 commons) 20 (4 commons) 16 (4 commons) 12 (2 commons) 8 (2 commons)

MB89160L Series

■ ORDERING INFORMATION

Part number	Package	Remarks
MB89163L-PFV MB89165L-PFV MB89P165-xxxx-PFV	80-pin Plastic LQFP (FPT-80P-M05)	
MB89163L-PF MB89165L-PF MB89P165-xxxx-PF	80-pin Plastic QFP (FPT-80P-M06)	
MB89163L-PFM MB89165L-PFM MB89P165-xxxx-PFM	80-pin Plastic LQFP (FPT-80P-M11)	
MB89W165-xxxx-PF	80-pin Ceramic QFP (FPT-80C-A02)	
MB89PV160-xxxx-PF	80-pin Ceramic MQFP (MQP-80C-P01)	

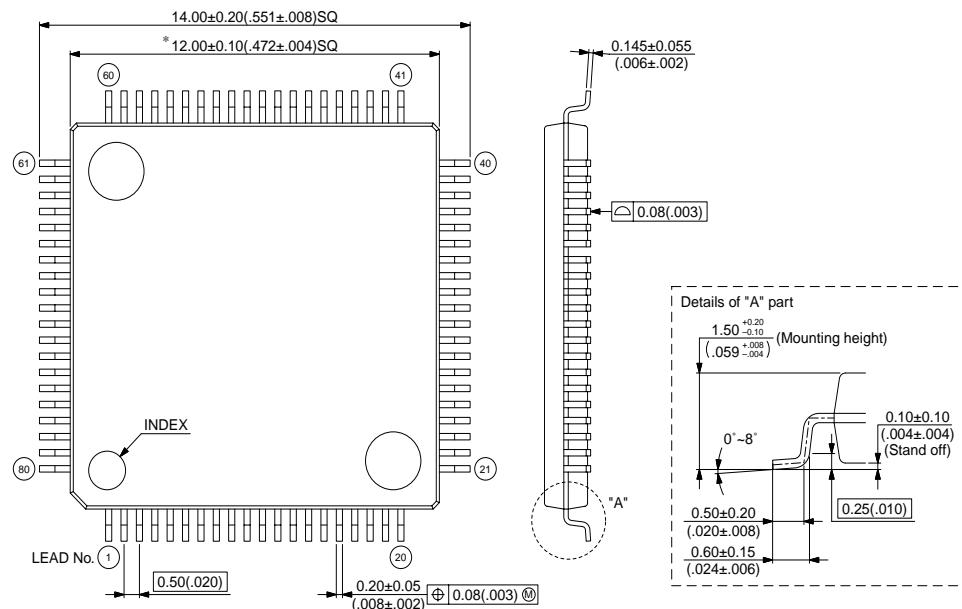
Note : For information on xxxx, see ■ VERSIONS.

MB89160L Series

■ PACKAGE DIMENSIONS

80-pin plastic LQFP
(FPT-80P-M05)

Note 1) * : These dimensions do not include resin protrusion.
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.

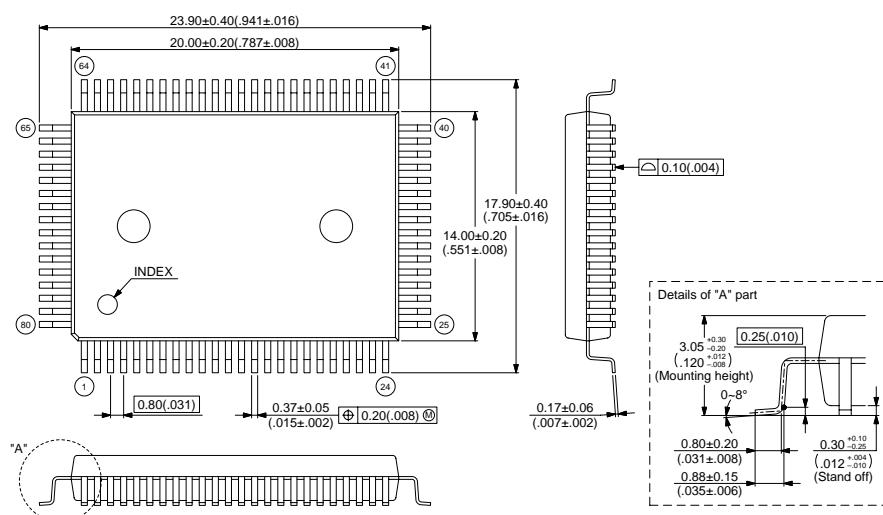


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Dimensions in mm (inches).

80-pin plastic QFP
(FPT-80P-M06)

Note 1) * : These dimensions do not include resin protrusion.
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.



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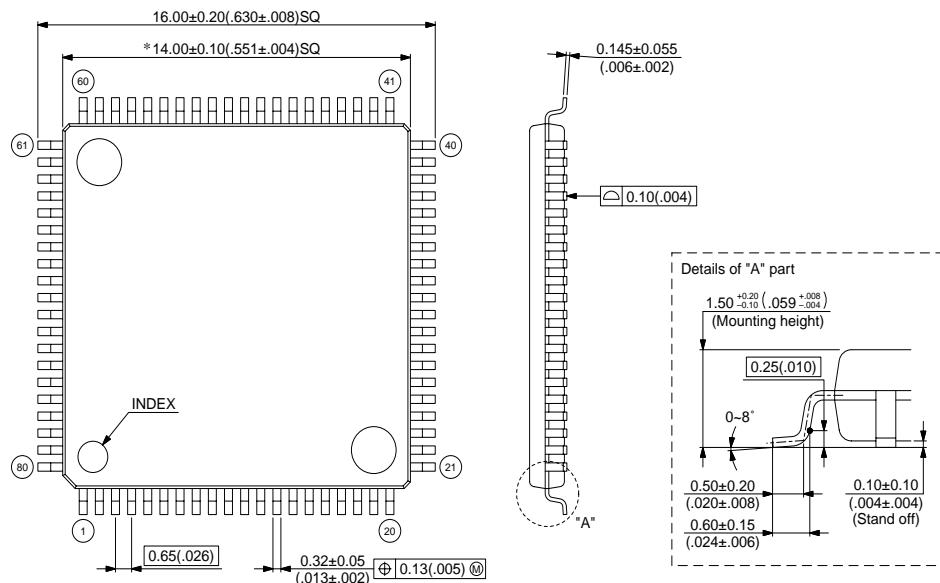
Dimensions in mm (inches).

(Continued)

MB89160L Series

80-pin plastic LQFP
(FPT-80P-M11)

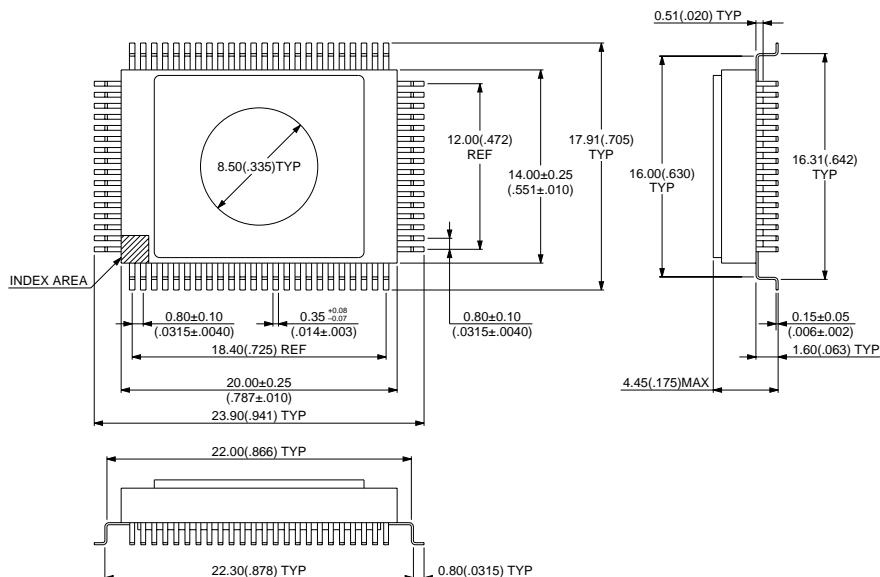
Note 1) * : These dimensions do not include resin protrusion.
 Note 2) Pins width and pins thickness include plating thickness.
 Note 3) Pins width do not include tie bar cutting remainder.



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Dimensions in mm (inches).

80-pin ceramic QFP
(FPT-80C-A02)



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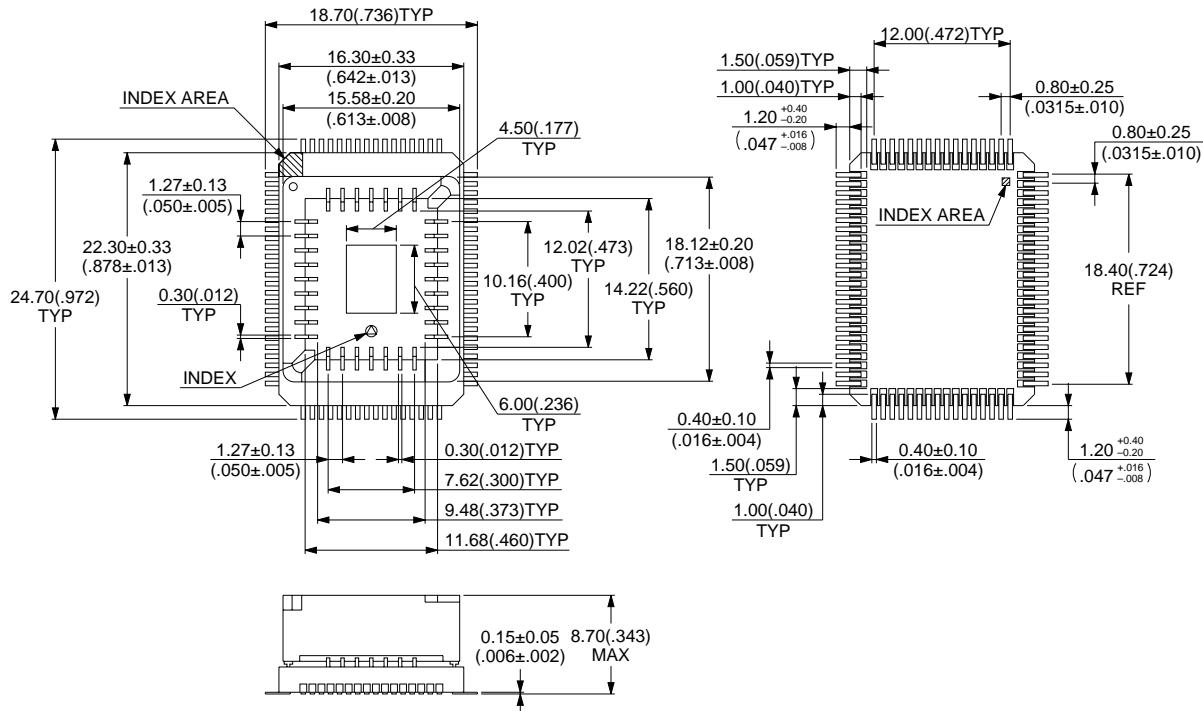
Dimensions in mm (inches).

(Continued)

MB89160L Series

(Continued)

80-pin ceramic MQFP
(MQP-80C-P01)



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Dimensions in mm (inches).

MB89160L Series

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